

DIGITAL WE DAYS

2023



OPTICAL MULTI-GIGABIT LINKS FOR
AUTOMOTIVE

Partnered with KDPOF

WÜRTH ELEKTRONIK MORE THAN YOU EXPECT

TODAY'S SPEAKERS



PRESENTATION

Óscar Ciordia
Marketing and Sales Director



MODERATION

Markus Eberle
Marketing Department

INFORMATION ABOUT THE WEBINAR

You are muted during the webinar.

However, you can ask us questions using the chat function.

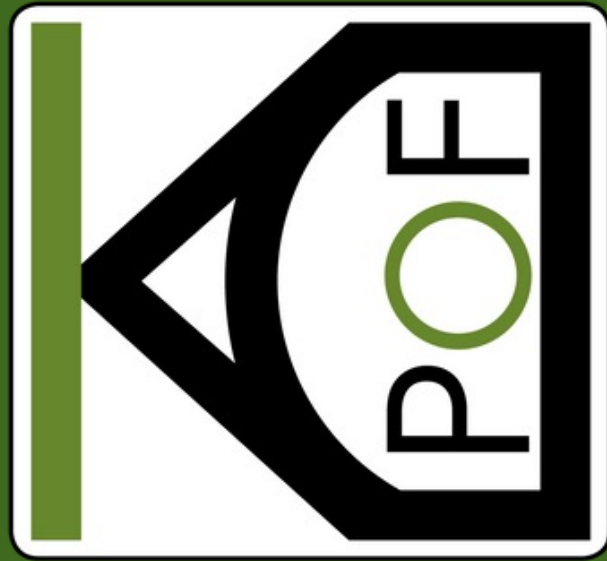
Duration of the presentation 30 Min
Q&A: 10 – 15 Min

Any questions?
No problem! Email us digital-we-days@we-online.com

Please help us to optimize our webinars!
We are looking forward to your feedback.

On our channel Würth Elektronik Group
And on [Digital WE Days 2023 YouTube Playlist](#)

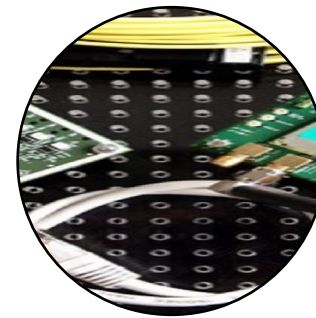




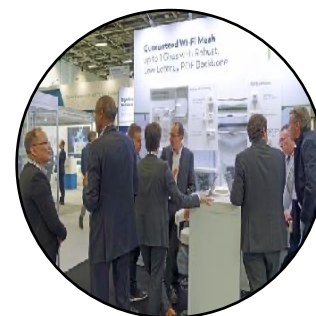
Index



Company Presentation



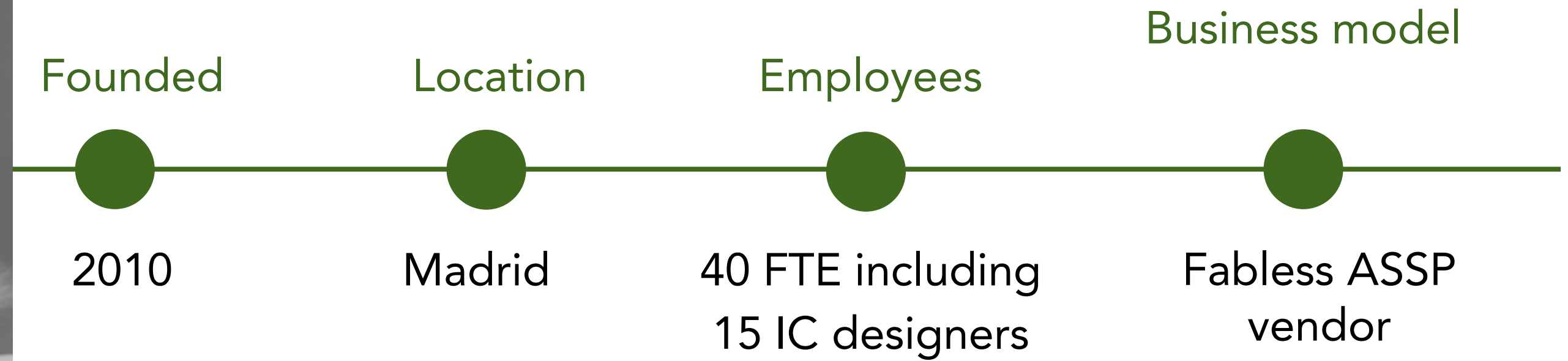
Automotive Optical Multi-gigabit



Timeline



COMPANY OVERVIEW





COMPANY OVERVIEW

- Head Quarters
 - Madrid (Spain)
- Other locations
 - France
 - Valencia (Spain)
- Commercial offices
 - Sweden
 - Germany
 - Japan
 - Korea
 - GC





BUSINESS AT A GLANCE

In-house capabilities

- Digital, AMS, Optoelectronics and optics design
- IC & photonics characterisation, automotive qualification, failure analysis

Patents granted

- Transceiver EP74397 EP98515 EP80387
- TIA EP105112
- LED Driver EP105113

Associations



Standards



KDPOF actively participated in standardization process



TECHNOLOGY

Key products

- Transceiver
- Transimpedance Amplifier (TIA)
- LED Driver
- FOT (optical front end)

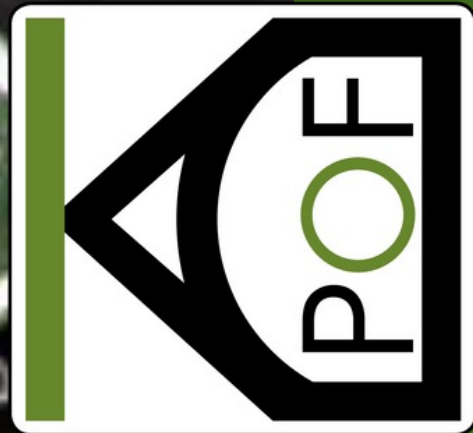
Supply chain

- Wafer fabrication with TSMC and XFAB
- Packaging and testing with ASE

End markets

- Main focus Automotive
- Applications in Home and Industrial

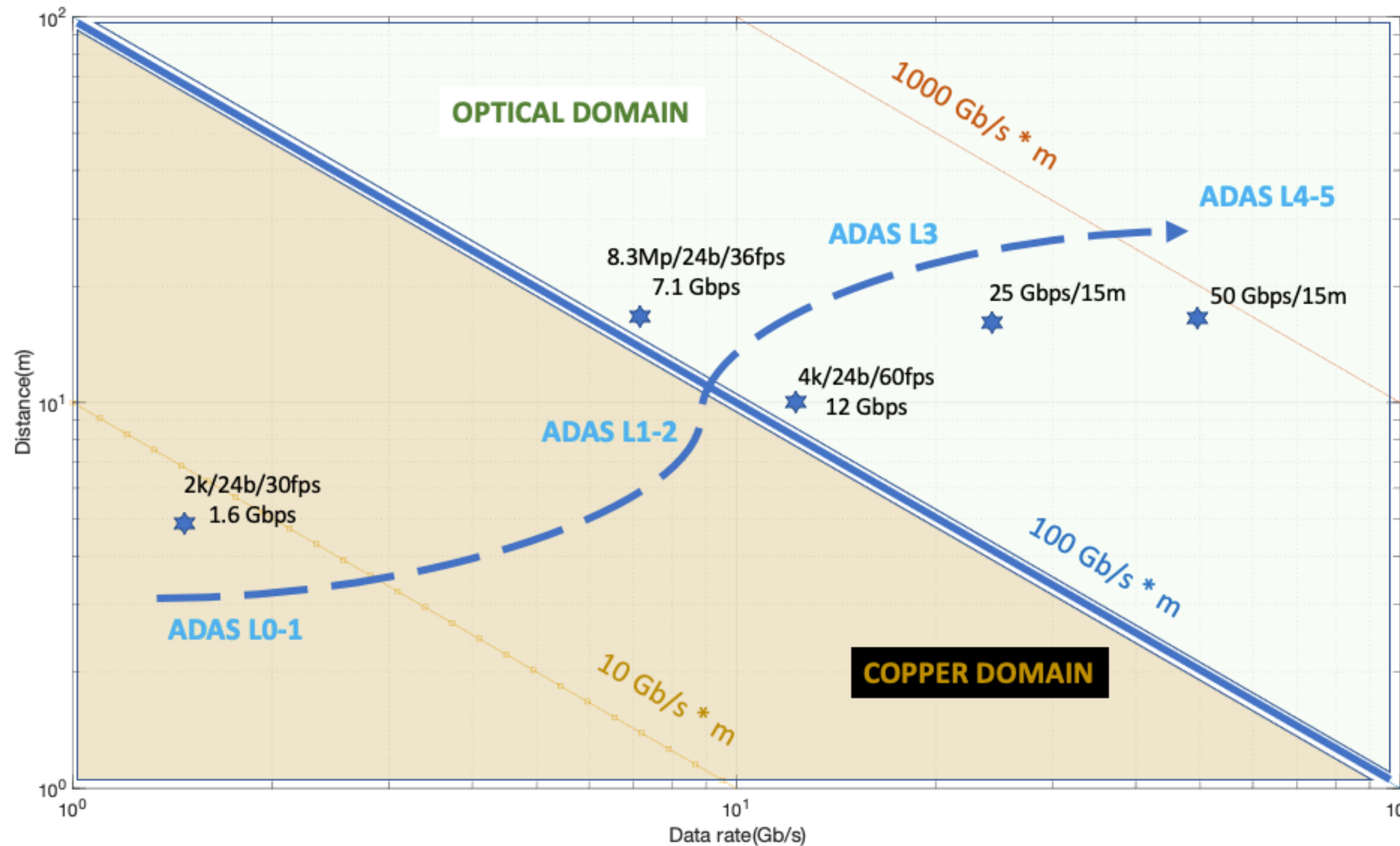




Automotive Optical Multi-gigabit (1 Gb/s up to 50 Gb/s)



KDPOF VIEW: History shows copper links migrate into optical as needs grow



□ Current known data rate needs in Automotive application are reaching 100Gbps.m threshold

Sensor	Data Rate (~2030)	Distance (m)	Data x Distance (Gbps.m)
Cameras	10G+	10-15	>100
Radars	10-20Gbps	5 - 10	50 - 200
Displays (4k, 60fps)	10Gbps	5 - 10	50 - 100
Backbone	50G+	5	>250

Source: IEEE802.3cz Task Group meeting presentations

Elaborated from : A. V. Krishnamoorthy et al., "Progress in Low-Power Switched Optical Interconnects," IEEE J. Select. Topics Quantum Electron., vol. 17, no. 2, pp. 357-376, Mar. 2011



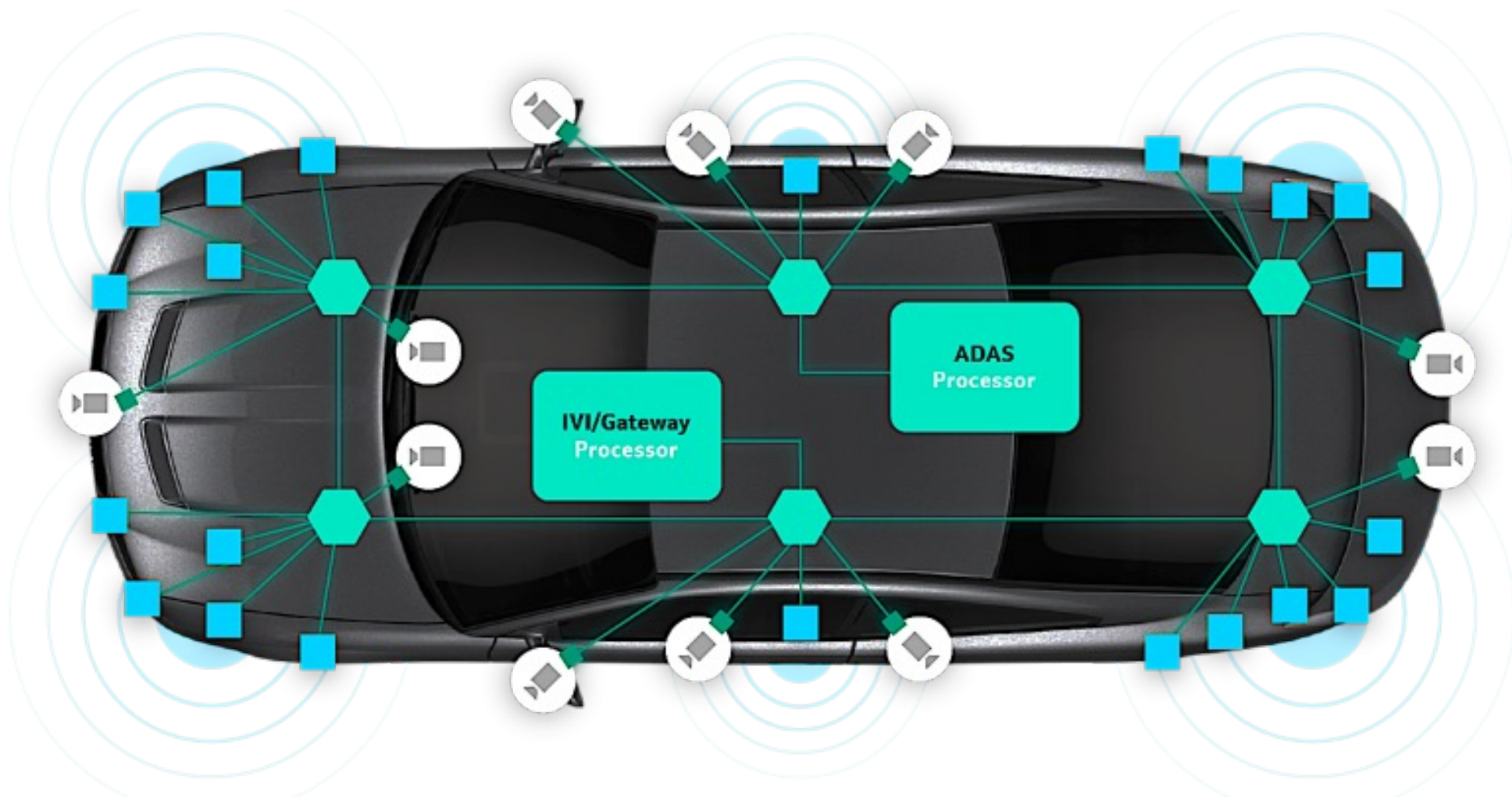
COPPER TRANSMISSION CAN EVOLVE, BUT NOT WITHOUT SIGNIFICANT CHALLENGES

Technical Approach	Associated issues
Add more (parallel) lanes	<ul style="list-style-type: none">• Cost and weight of cables• Connection size increase• Decreased mechanical flexibility
Larger conductors (& shielding)	
Increase DSP complexity (equalization, FEC, etc.)	<ul style="list-style-type: none">• Higher power consumption• Increased latency
Higher signal amplitude	<ul style="list-style-type: none">• Higher power consumption• Increased EMC issues

* Source: Corning Inc.



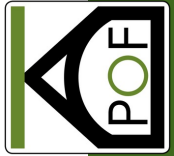
Data links support autonomous and electric vehicles



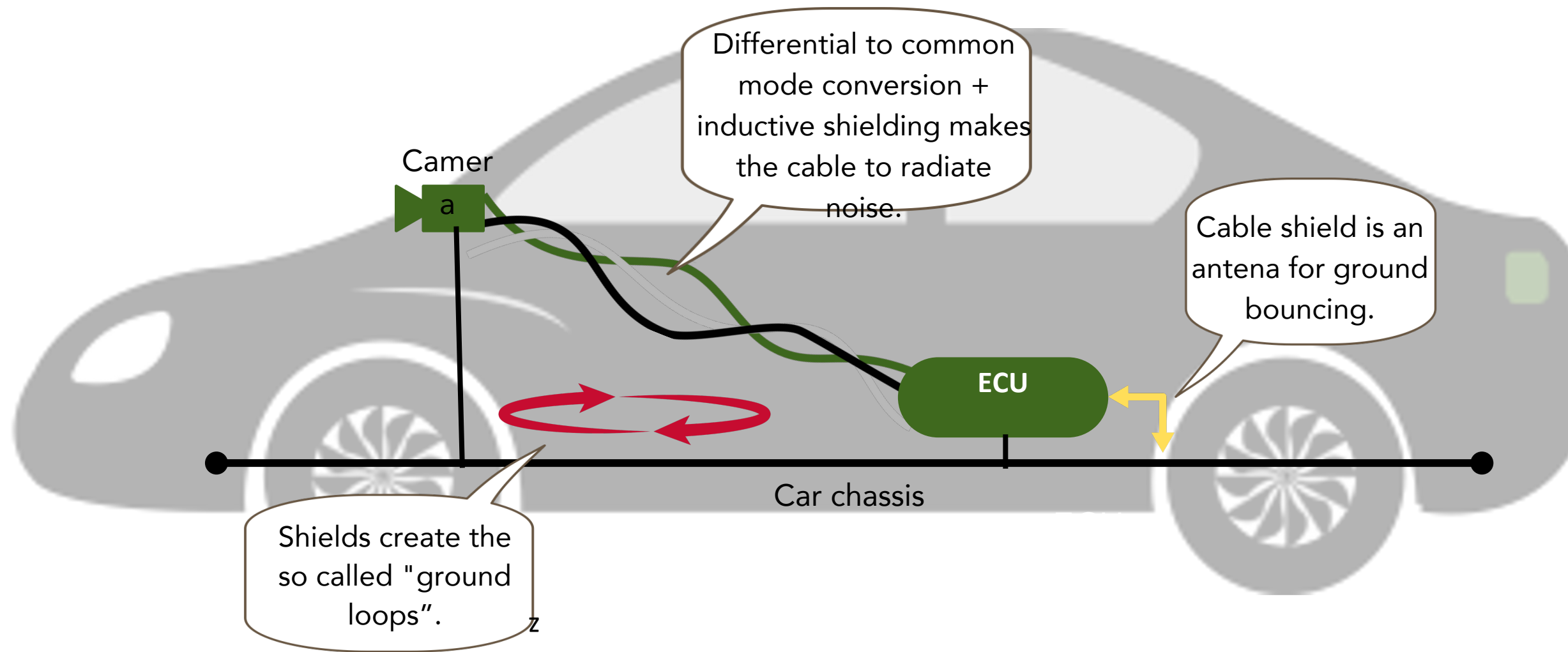
<https://www.designnews.com/automotive-engineering/why-cars-are-migrating-zonal-electric-architecture>

Exponential increase of the electronics complexity and speed

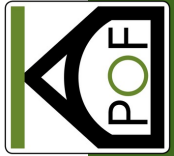
- Connected cars
- Electrical and autonomous vehicles
- High-speed cameras and sensors (radar, lidar...)
- Centralized high performance computing units processing all raw data
- Zonal architecture, sensor fusion
- Black-boxes



Copper-based data-links do not scale



- Attenuation /bandwidth Attenuation increases at high frequencies
- EMC problems The higher the communication speed, the worse is the problem
- Electrical noise Mainly in EVs
- Galvanic Isolation Battery and engines operate at up to 800V and also connected to the 12V of the car



Automotive requirements for any link technology

Reliability

- <10 FIT over 15 years of life-time

Qualification plan

- According to the new **AEC-Q102-003** standard
Operation ambient temperature (grade 2): **-40 °C ~ +105 °C**

Feedback from Tier1

- IC (package, pitch, SMD...)
- Connector housing (two-step assembly, waterproof, environmental...)
- Connector-IC mating (manufacture & assembly tolerances)

Cable and
connector
performance

- Bending: permanent, instant, dynamic, micro-bending
- Vibration, shock test, mechanical loads
- Chemical loads

Link budget

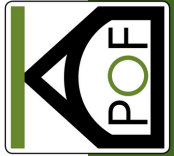
- Optical parameters (emission profile, wavelength, spectral width, AOP...)
 - Electrical parameters (electrical model, linearity, bandwidth...)
- Performance: **40 m – 4 IC**



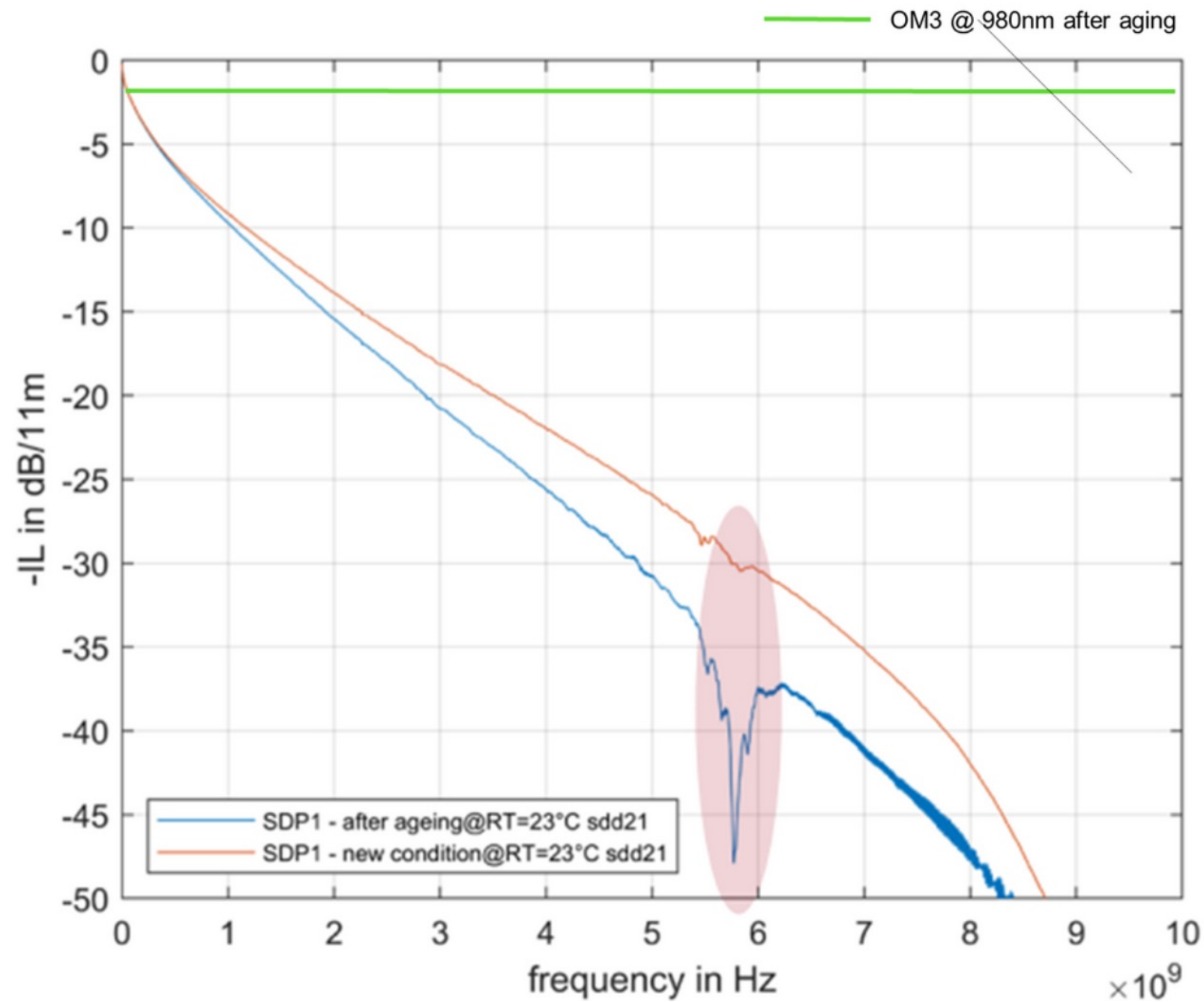
Ethernet has a new standard that complies with requirements

IEEE Std 802.3cz

- Published in **2023**
- Ethernet PHYs specification targeted for Automotive application
 - Support of data rates of **2.5, 5, 10, 25 and 50 Gb/s** (single lane)
 - Support for implementations qualified AEC-Q100 grade 2 (operation T_J & T_{BS} **-40°C to 125°C**)
 - Support of max reach of **40 meter** (cars, buses, trucks)
 - Support for low-cost, small-size, auto-grade optical connectors (up to **4 inline connections**) and cables
 - Support for advance **diagnosis, wake-up & sleep** functions, **dependability** function with **OAM** channel
 - Support for Energy Efficient Ethernet (**EEE**) for big power saving in low traffic conditions, **asymmetric** rate use cases
- Leverage mature components from other industries: **OM3, VCSELs and photo-diodes**



Optical: simplicity makes it the optimal solution



https://grouper.ieee.org/groups/802/3/cy/public/adhoc/koeppendoerfer_3cy_01_10_28_20.pdf

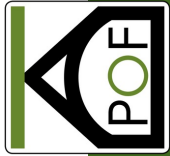


Optical transceiver does NOT have to compensate:

- High attenuation vs frequency
- Ageing

Optical transceiver's electronics are much simpler

- **Smaller silicon area**
- **Shorter latency**
- **Lower power consumption**
- **Cheaper**



Optical vs Copper trceiver comparison

Optical PHY

Copper PHY

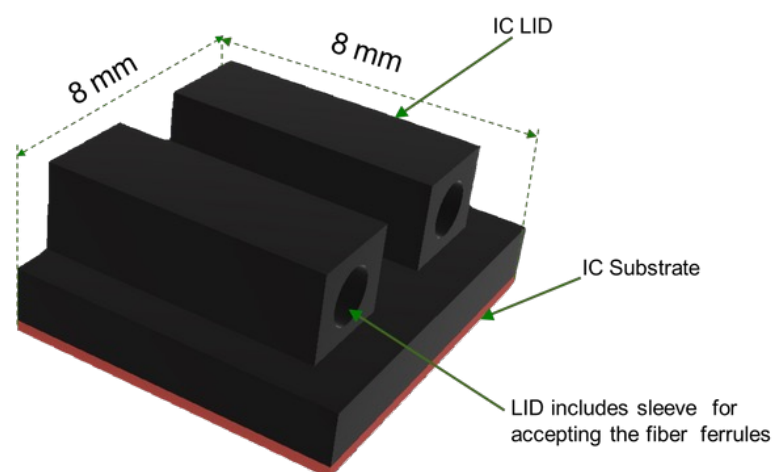
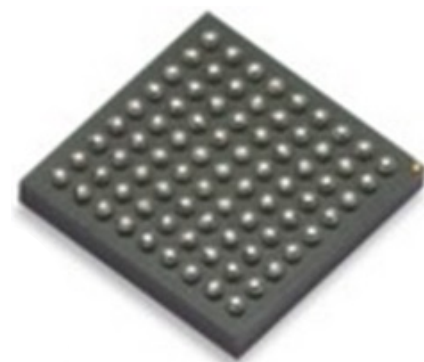
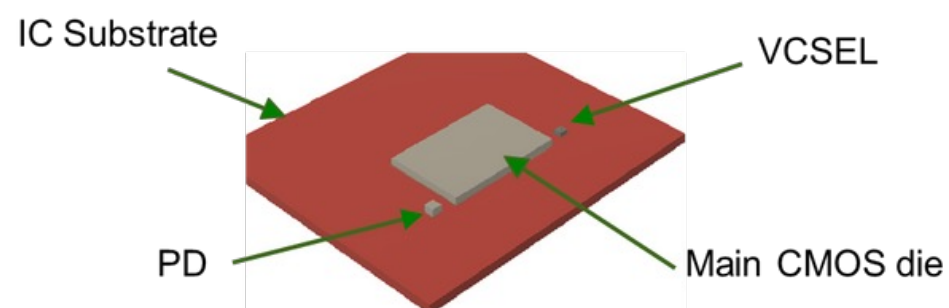
Single-lane max. rate	50 Gb/s according to 802.3cz. 100 Gb/s feasible	25 Gb/s according to 802.3cy.
Supported max channel length	> 40 meters for at least up to 50 Gb/s	< 11 meters
Supported # inline connections	At least 4 for rates ≤ 25 Gb/s. At least 2 for rates ≥ 50 Gb/s	Max. 2 for rates ≥ 2.5 Gb/s
Scalability	Same cables and connectors for rates between 1G and 100 Gb/s	Cable and connector categories depend on data-rate
Equalizer complexity	FFE + DFE: < 10 taps total	100's of taps needed
Echo cancelling	No	100's of taps needed
FEC complexity	RS-FEC (544,522), GF(2 ¹⁰). Complexity FOM = $m \cdot (n-k) = 220$	≤ 10 Gb/s: RS (360,326), GF(2 ¹⁰). FOM = $m \cdot (n-k) = 340$ ($> +50\%$) 25Gb/s: RS-FEC (936,846), GF(2 ¹⁰). FOM = $m \cdot (n-k) = 900$ ($> \times 4.5$)
Block inter-leaver for impulse noise	No	x4 necessary for 10 Gb/s. x8 be necessary for 25 Gb/s. Complexity scales quadratically with data-rate
Latency	10GBASE-AU is 1.1 us 25GBASE-AU is 0.45 us 50GBASE-AU is 0.23 us	10GBASE-T1 with 4x interleaved is 2.0 us (+80%) 25GBASE-T1 with 8x interleaved is 4.1 us (x9)
Start-up time	< 100 ms (shorter in optical as no master/slave config is needed)	< 100 ms
Modulation complexity	NRZ for ≤ 25 Gb/s. Low linearity analog circuits. Low ENOB A/D. PAM4 for 50 Gb/s	PAM4 for ≤ 25 Gb/s. High linearity and resolution D/A & A/D
Power consumption	Lower , based on complexity	Higher , based on complexity
Connectors cost	Lower : simple housing + ferrules	Higher : metal shielding
PCB integration	PHY IC placed close to the ECU edge PHY IC in the middle of the ECU close to uP/GPU/sensor/switch Port PCB area: ~ 22 x 16 mm²	PHY IC needs to be placed close to the ECU edge , close to MDI with critical layout Port PCB area: ~50 x 20 mm²
BOM	PDN passives, optical connector	PDN, EMI filter, ESD protection, CMC, DC block electrical connection
EMC cost	Much lower	Very high : most problems come up at vehicle level



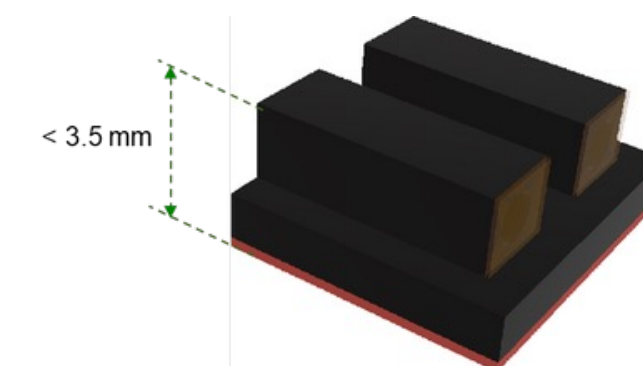
Packaging for the optical transceiver

IC Stand-alone transceiver with full integration of electronics over a common substrate with photonics (PD & VCSEL), and a lid integrating optics for optical coupling and alignment with fiber ferrules and EMC shielding.

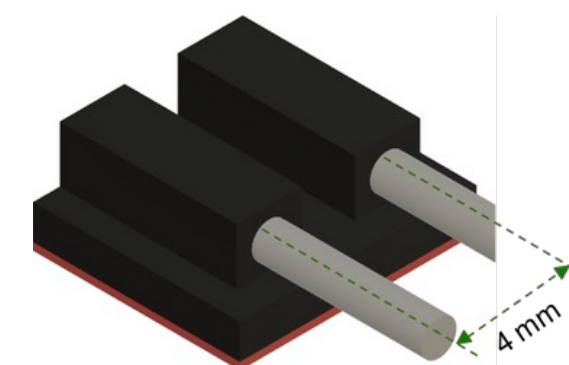
The component will support standard reflow assembly process.



IC with kapton tape to cover the two sleeve holes



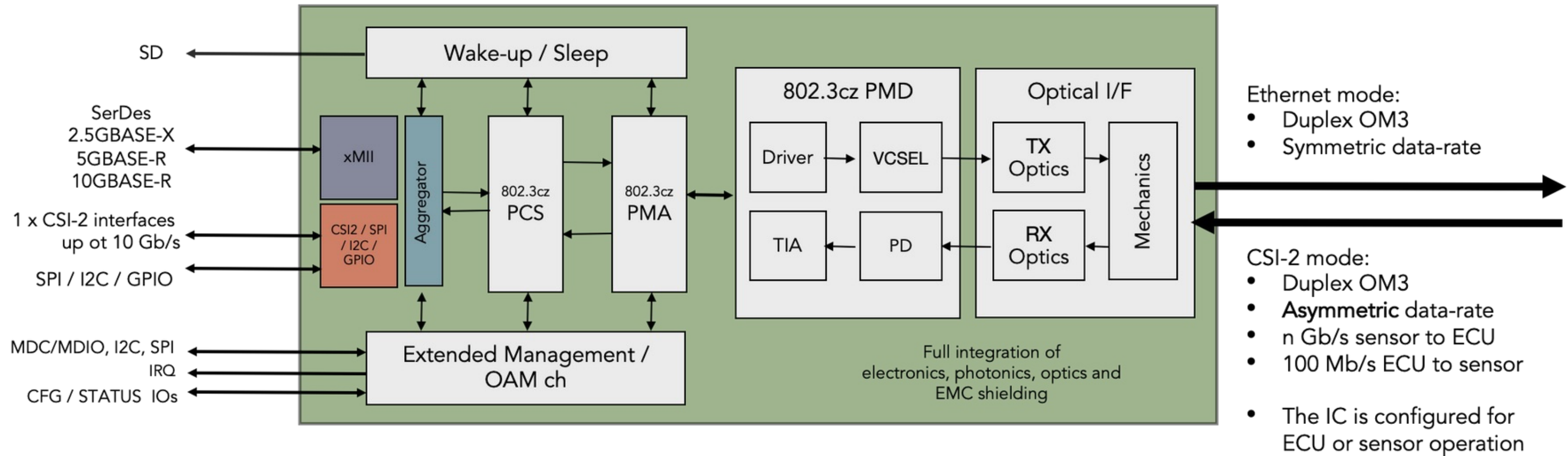
IC with fiber ferrules inserted on the sleeves.
This is done after package is mounted on the PCB





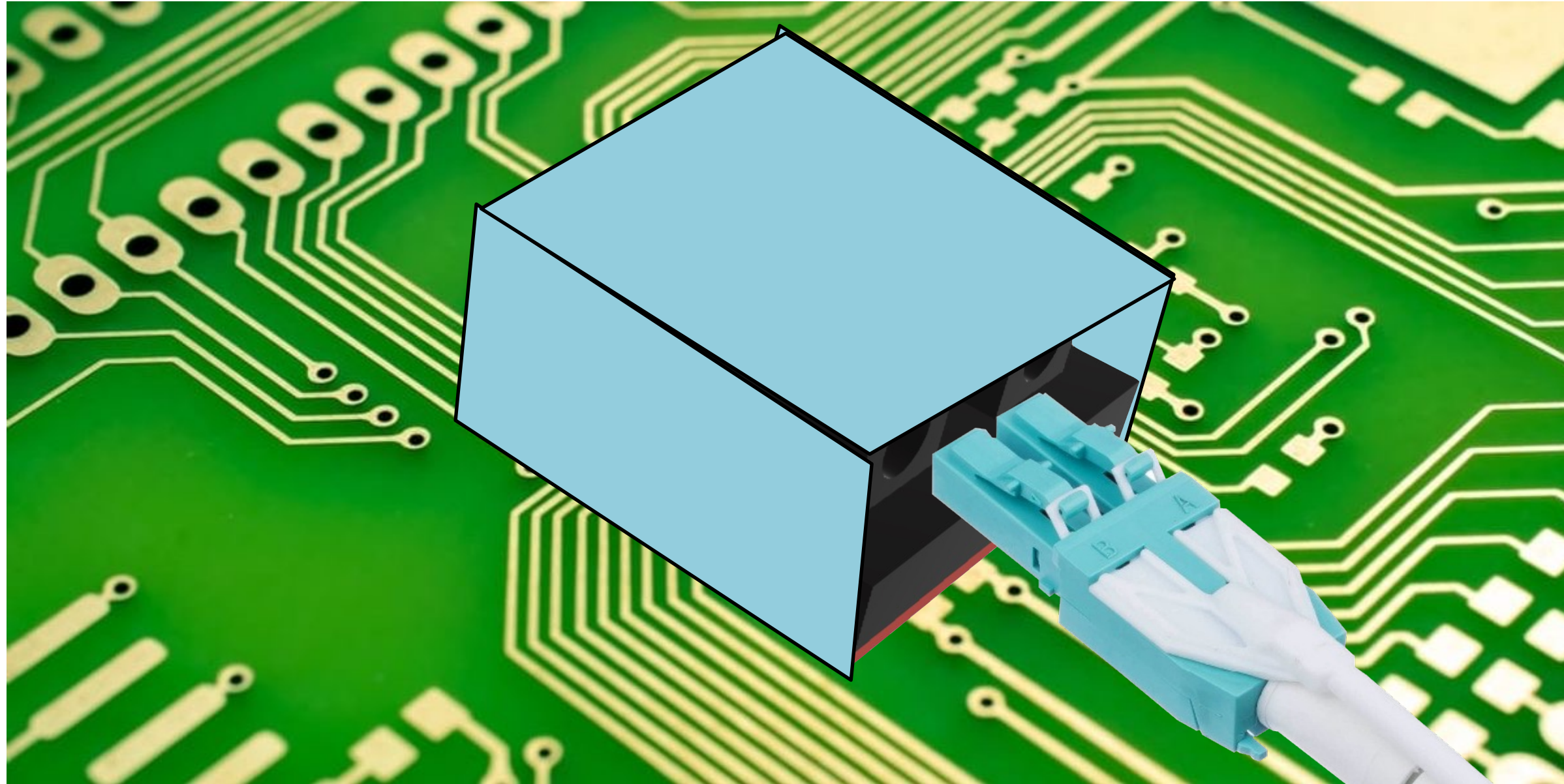
Optical transceiver block diagram

2-to-1 CSI-2 / SerDes / Optical PHY MUX



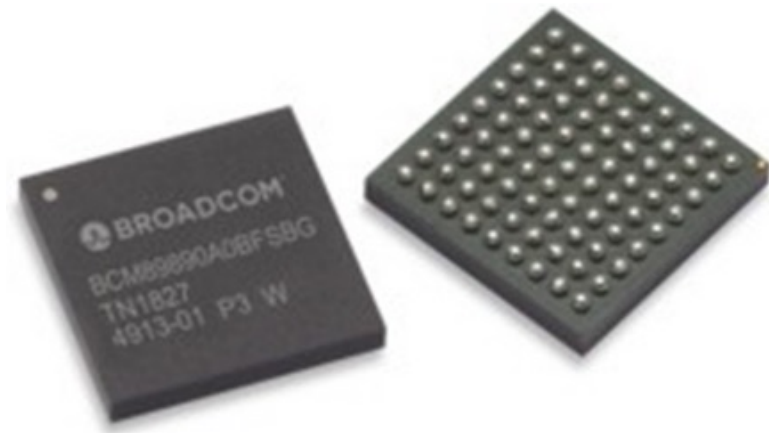


KD7251 + header assembly (concept)



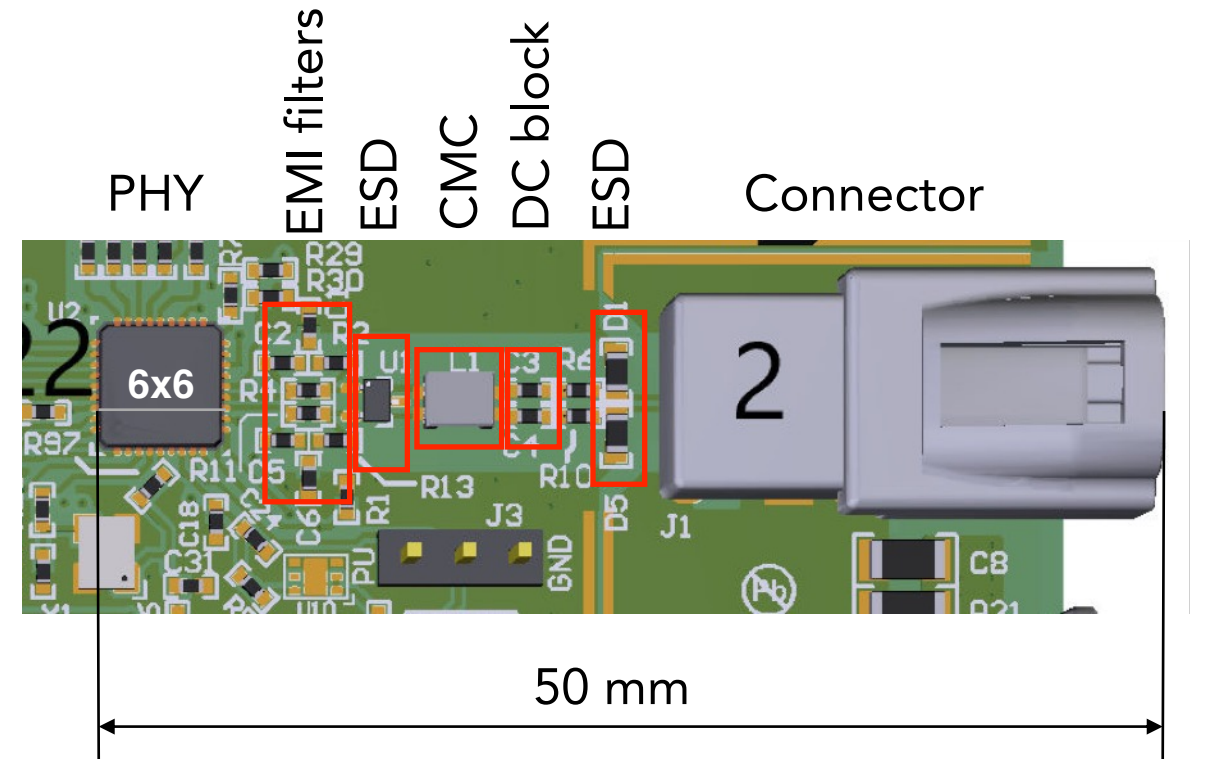
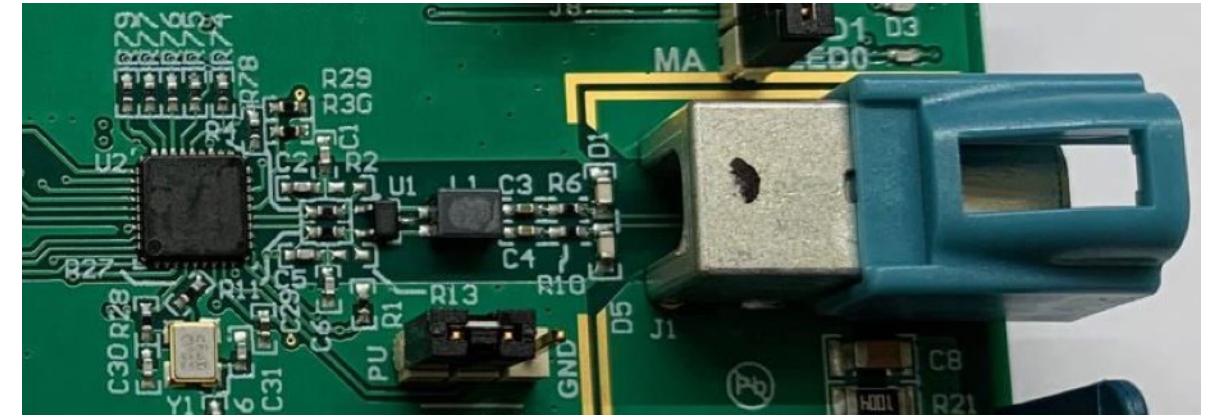


Port size comparison

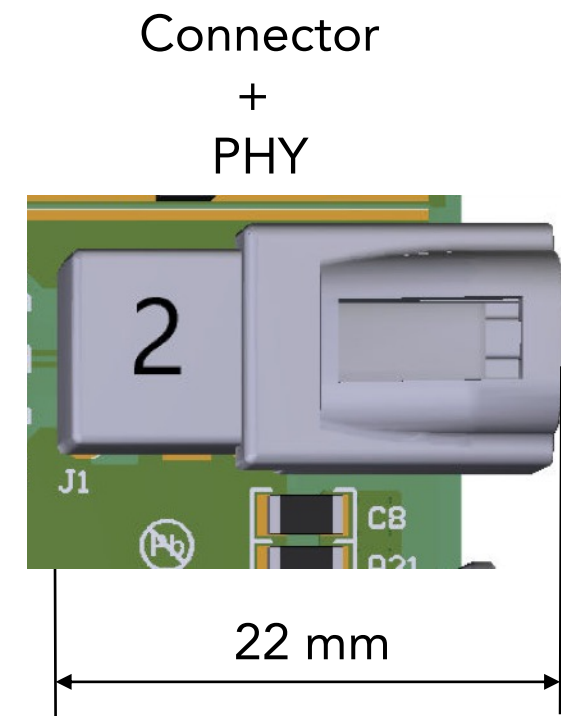


BCM89890, 8x8 mm, BGA-81

1000BASE-T1 port (TI)



10GBASE-AU port (KD)

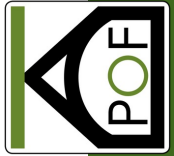




Camera and radar solution

- MIPI operation:
 - CSI-2 to CSI-2
 - CSI-2 to Ethernet with IEEE 1722/MIPI encapsulation
- I2C, SPI and GPIO support over IEEE 1722
- Multiple CSI-2 channels over a single duplex fibre
- Asymmetric optical operation:
 - Up to 12.5 Gb/s downstream
 - 1 Gb/s upstream
- 90° or 180° connectors
- Power supply over hybrid connectors and cables already prototyped
- Several TIER-1 and OEM interested; PoC available





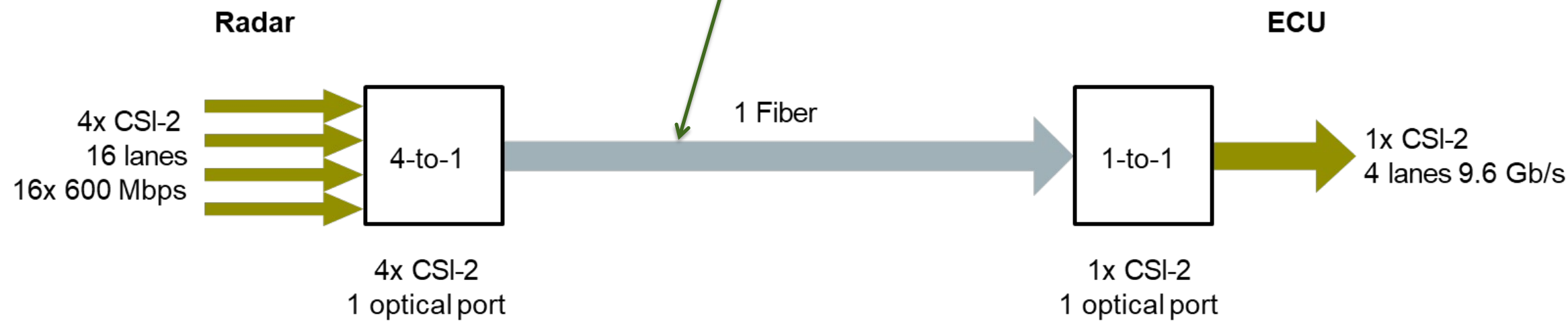
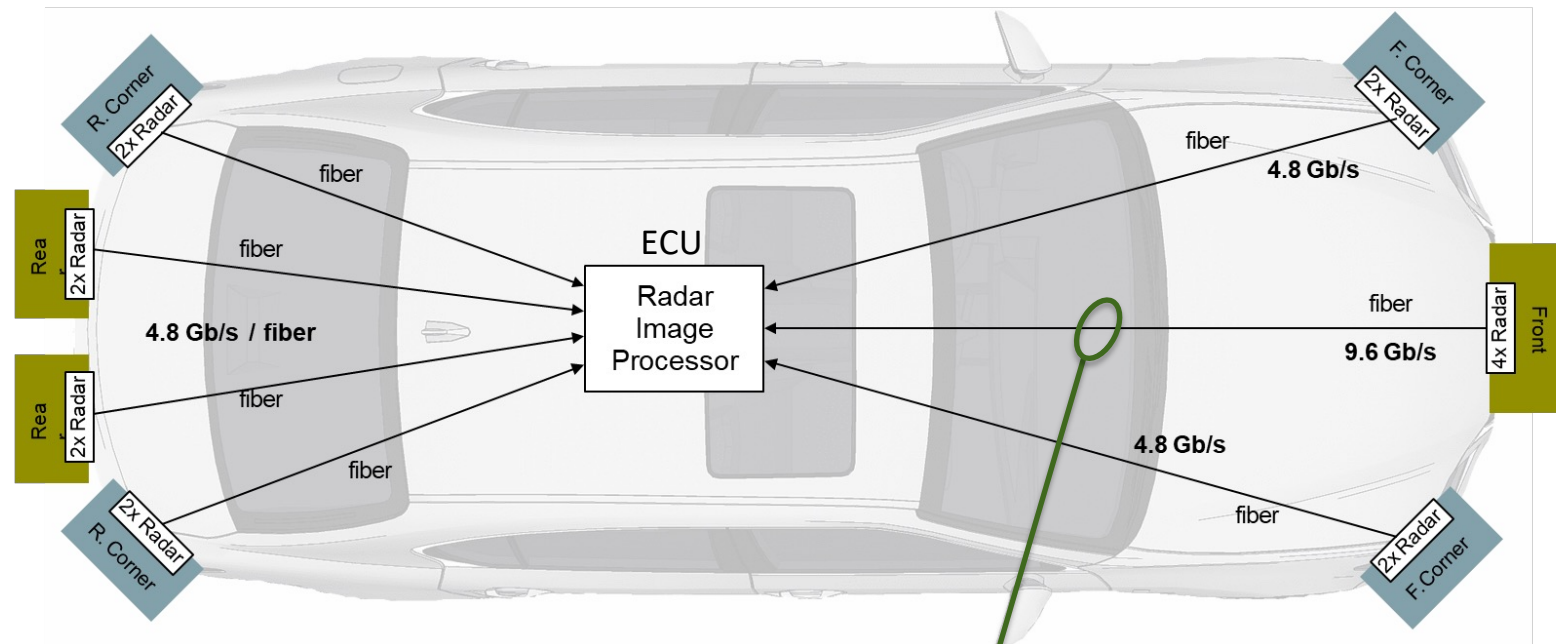
Satellite radar PoC

- 2 or 4 FMCW radar transceivers per sensor ECU (e.g. AWR2243)

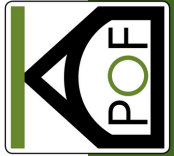
- 4-lane CSI-2 port per transceiver, 600 Mb/s per lane

- Data-rates:

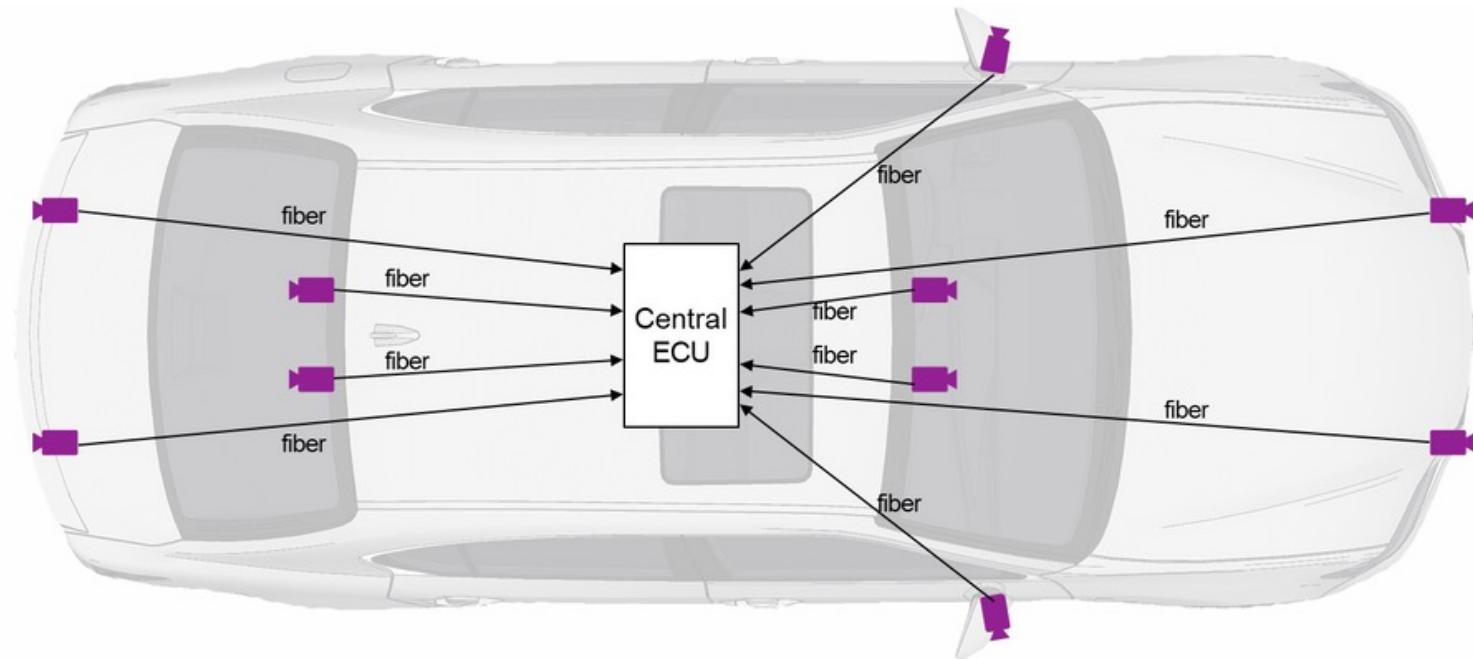
- $2 \times 4 \times 600 = 4800 \text{ Mb/s}$ (rear sensors and front corners)
- $4 \times 4 \times 600 = 9600 \text{ Mb/s}$ (front sensor)



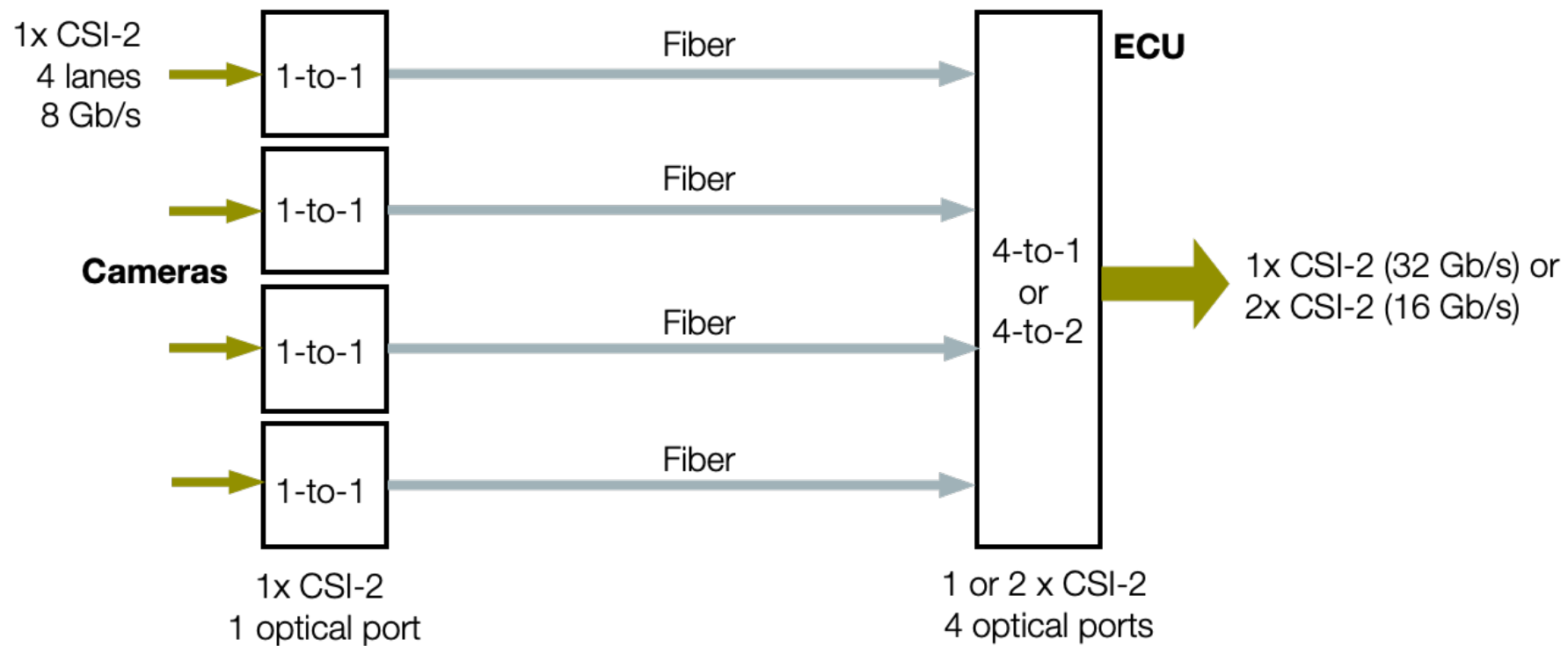
- Radar application is intensive in number of lanes and ports to get aggregated rate



Camera PoC



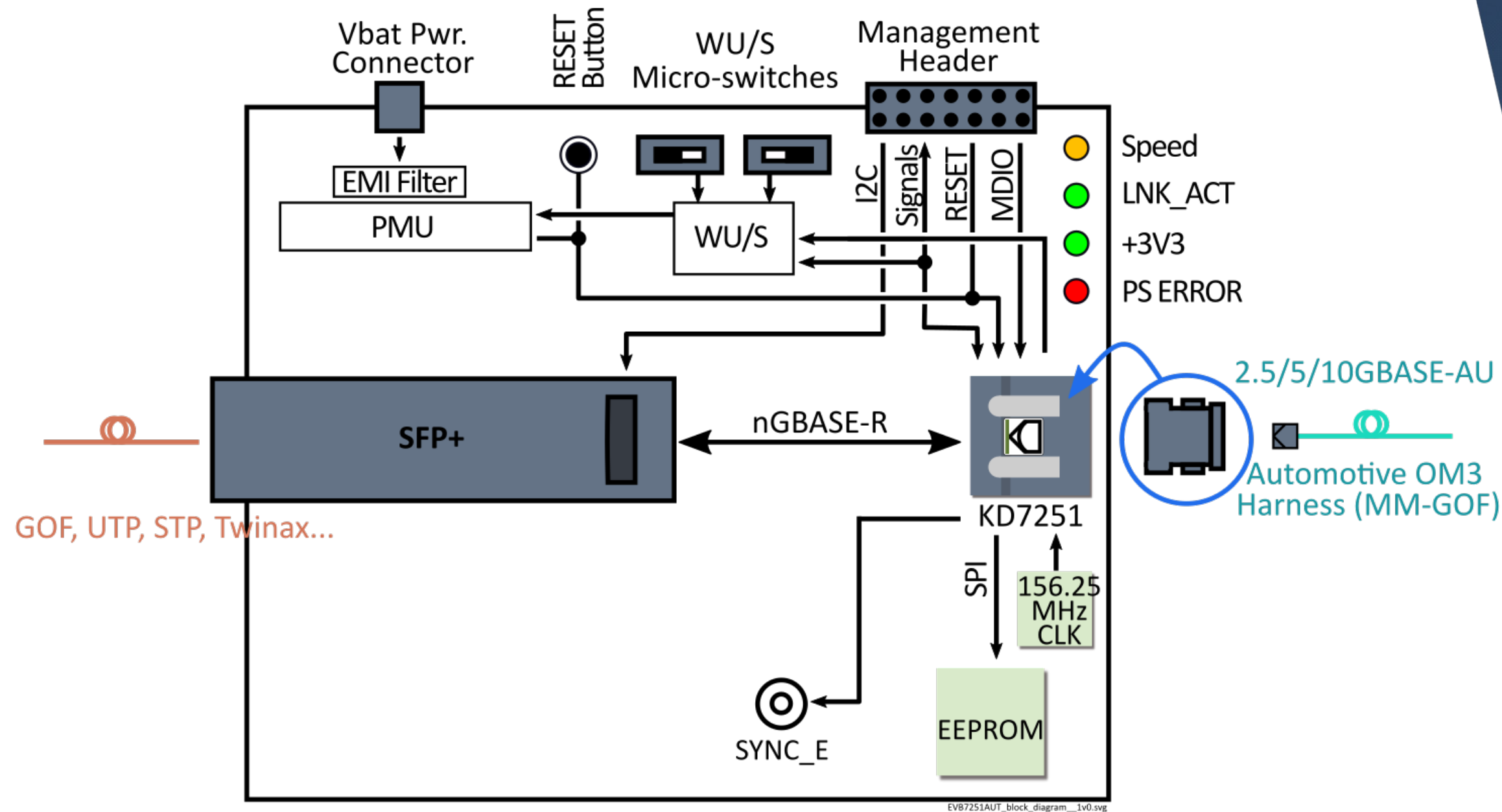
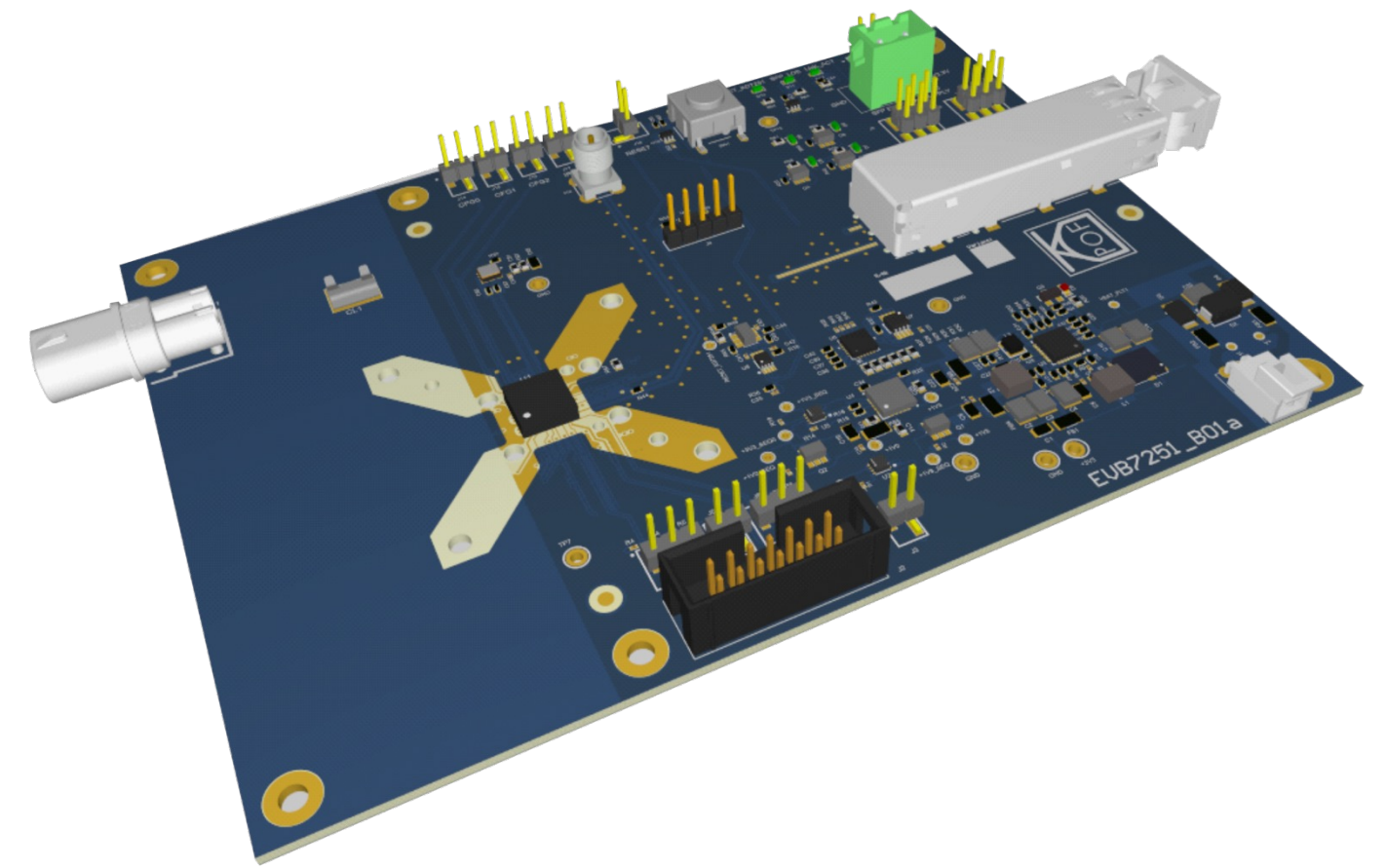
- Up to 10 cameras in high-end platforms with raw-data transmission
- Most of the cameras are ~3 Gb/s, some of them are ~8 Gb/s
- # CSI-2 ports per SOC limited, max 4 (e.g. Xavier, Renesas): virtual CSI-2 channels over single CSI-2 port are used
 - Dual and quad deserializers are currently used with coax and A-PHY



- Camera application is intensive in rate per lane with low number of lanes and ports



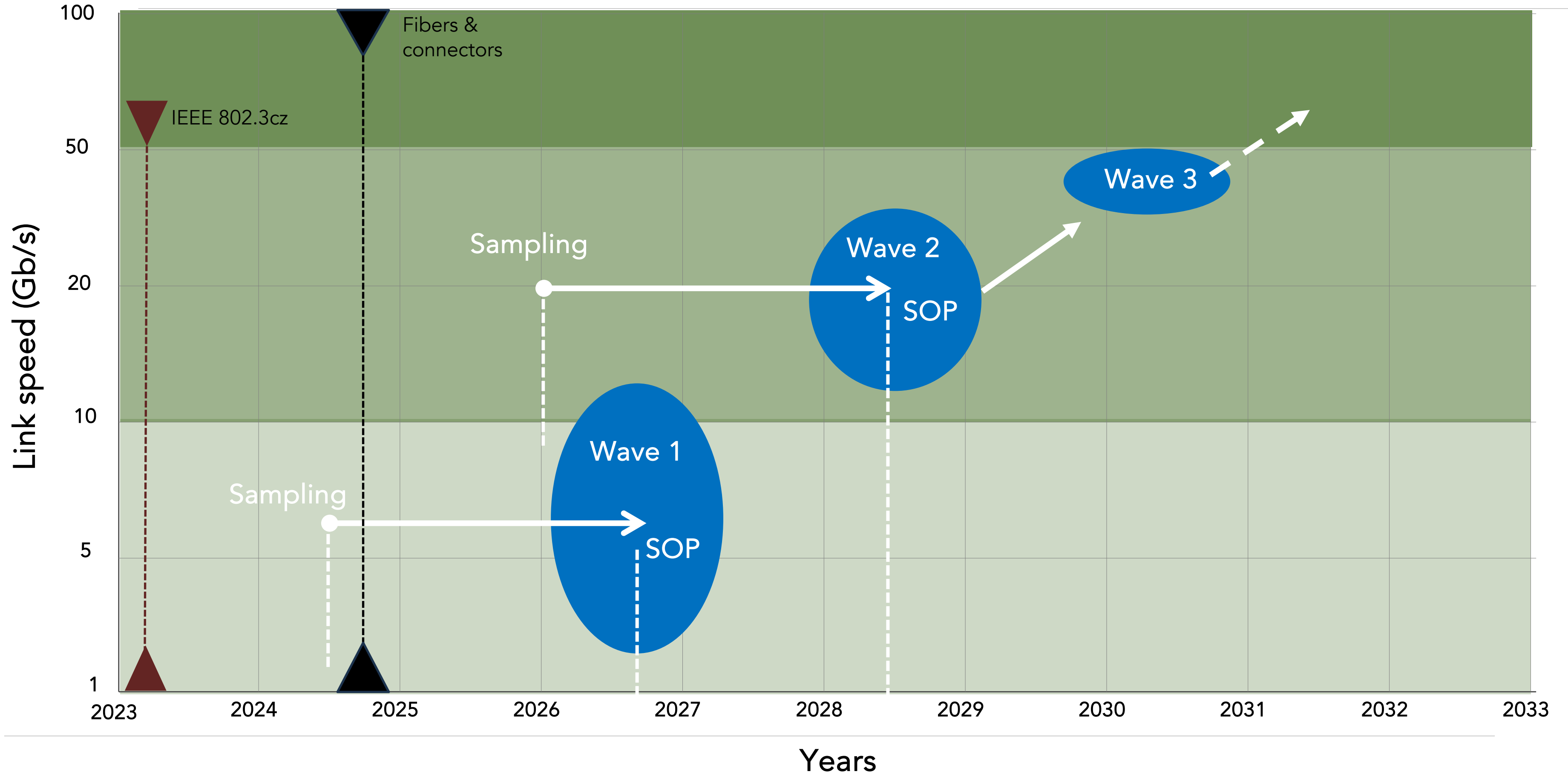
KD7251 eval-board

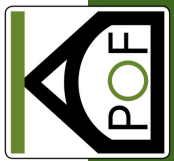


Availability September 2023



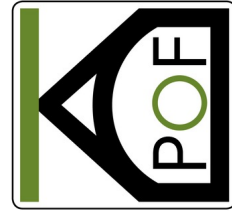
Optical Multi-gigabit Road Map





Ecosystem

- PHY vendors



- Connector and cables



- Test tools

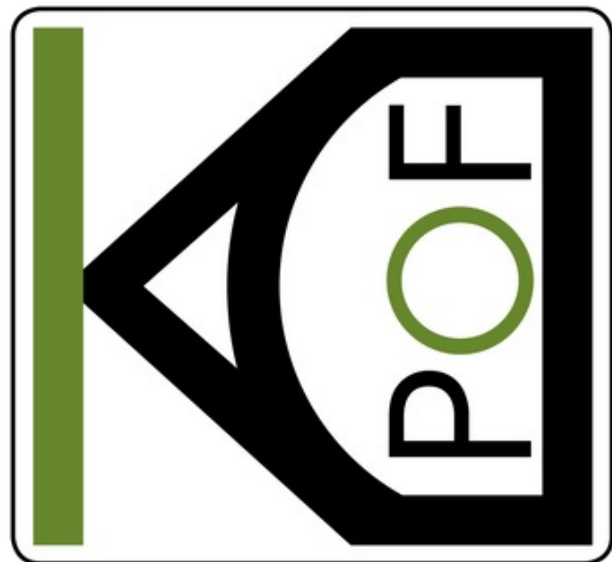


- Test houses



- Interested TIER-1 and OEMs (Some with actual projects)





www.kdpof.com



Thank you!

📍 Ronda de Poniente 14, 2CD, 28760,
Tres Cantos, Madrid, Spain.

☎ +34 918 043 387

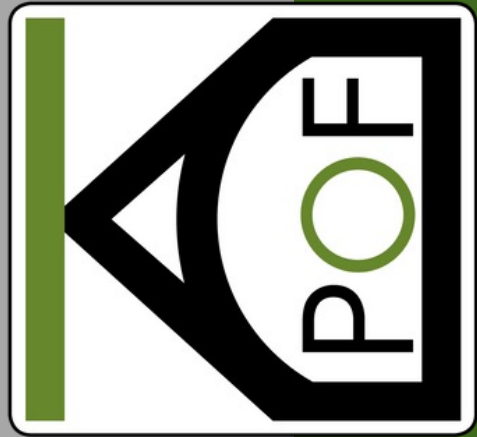
Questions

& Answers



We are here for you now!
Ask us directly via our chat or via E-Mail.

digital-we-days@we-online.com
o.ciordia@kdpof.com

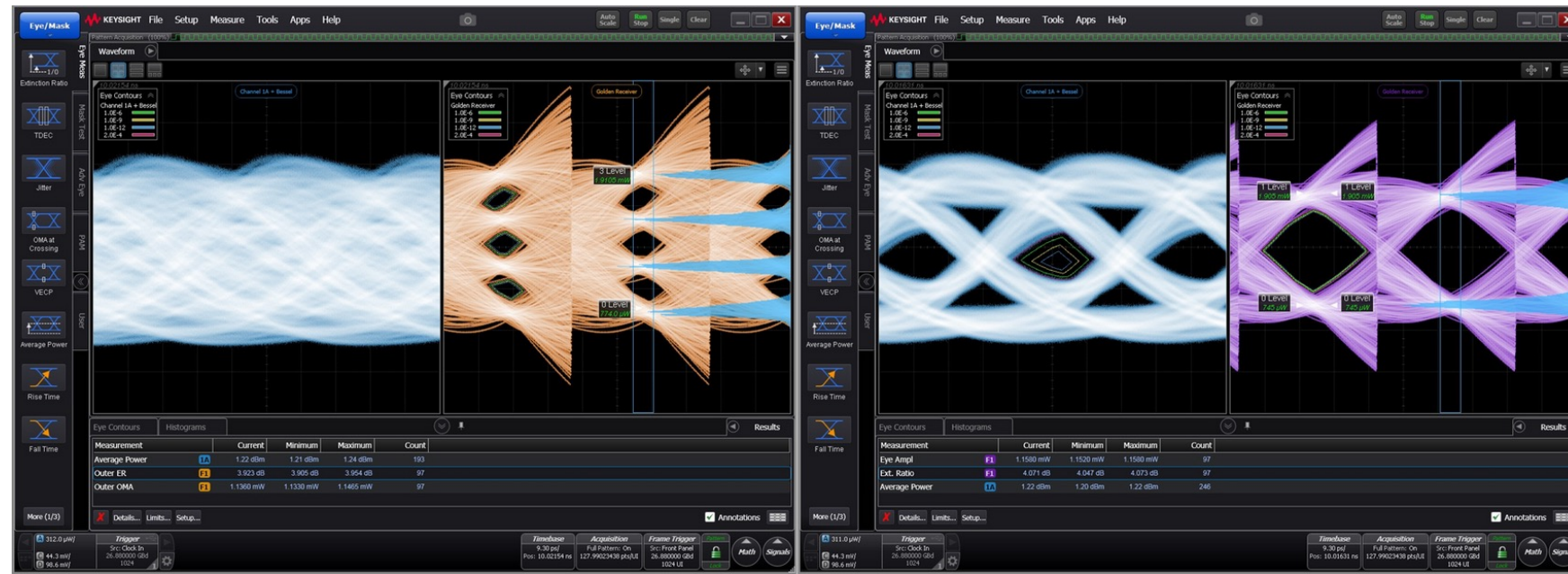


Backup slides



KDPOF advanced digital signal processing

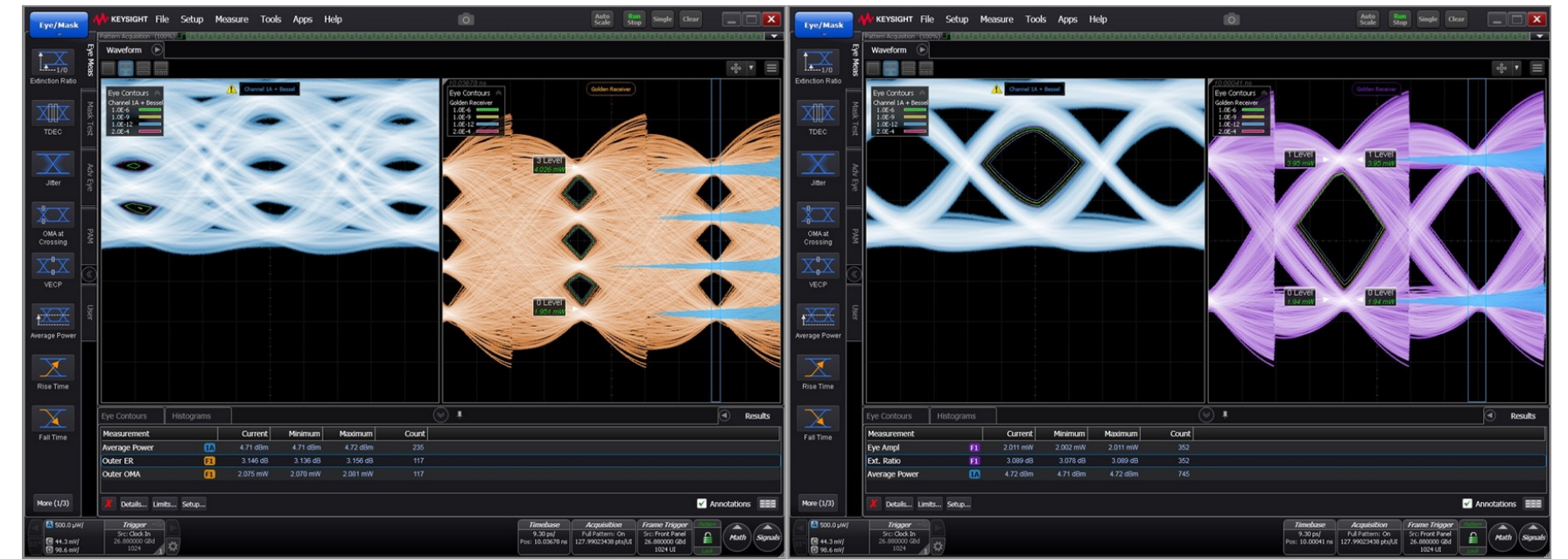
980nm, ER 4dB, 125°C, 40m OM3



53.76 Gb/s
PAM4

26.88 Gb/s
NRZ

980nm, ER 3dB, -40°C, 40m OM3



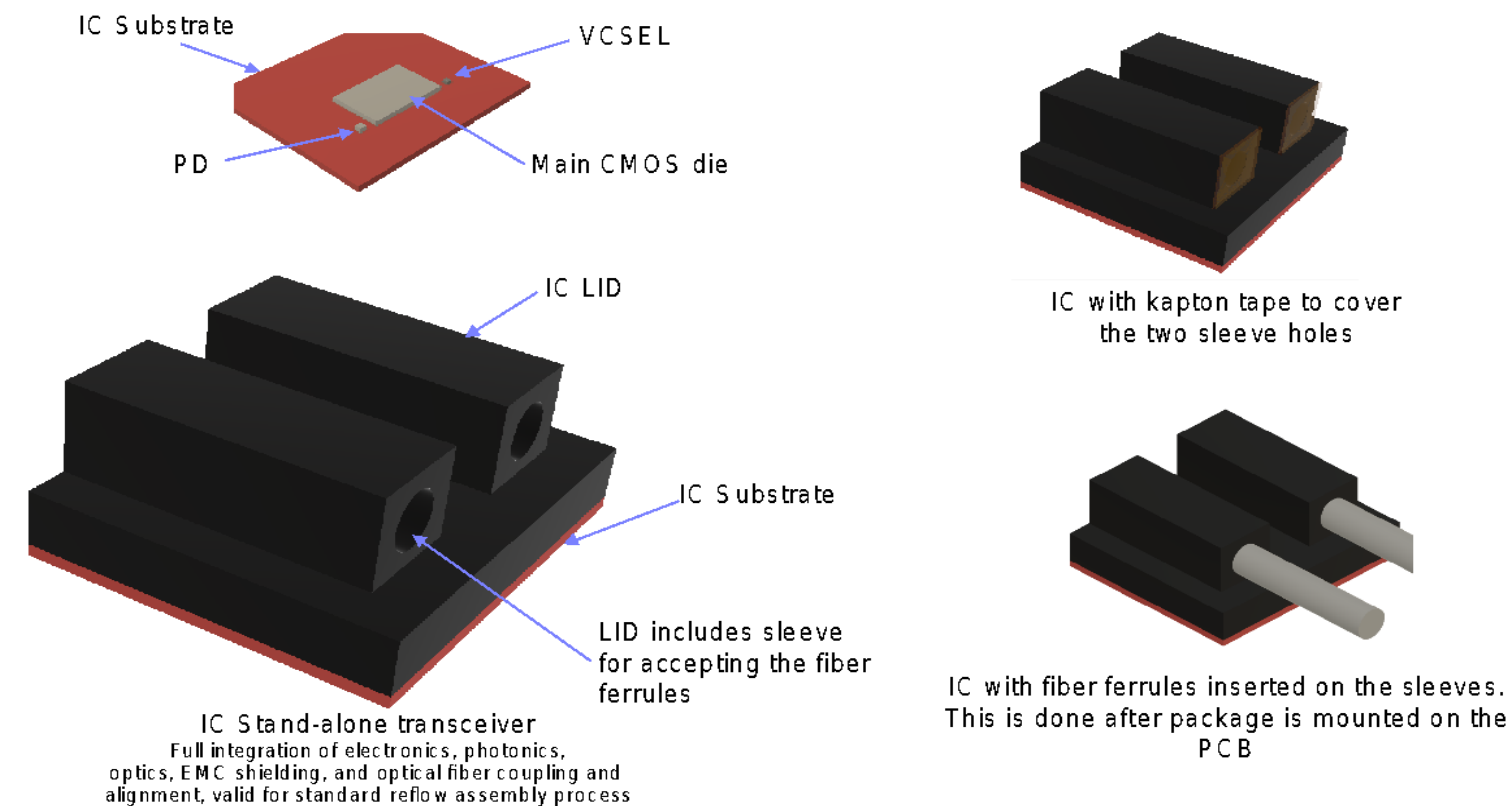
53.76 Gb/s
PAM4

26.88 Gb/s
NRZ



- Integration of ≥ 10 Gb/s copper PHYs in switch will be complicated
- Optical transceiver will always be in the connector
 - Middle of the board and edge connector options possible
- Integration of PCS & PMA in switch no sense
- Different electrical interfaces to support connection to switch
- Multiple port transceivers is the most probable way of integration.
High density connectors
- In collaboration with switch IC suppliers to agree on interfaces

Multi-Gigabit Optical Automotive ICs



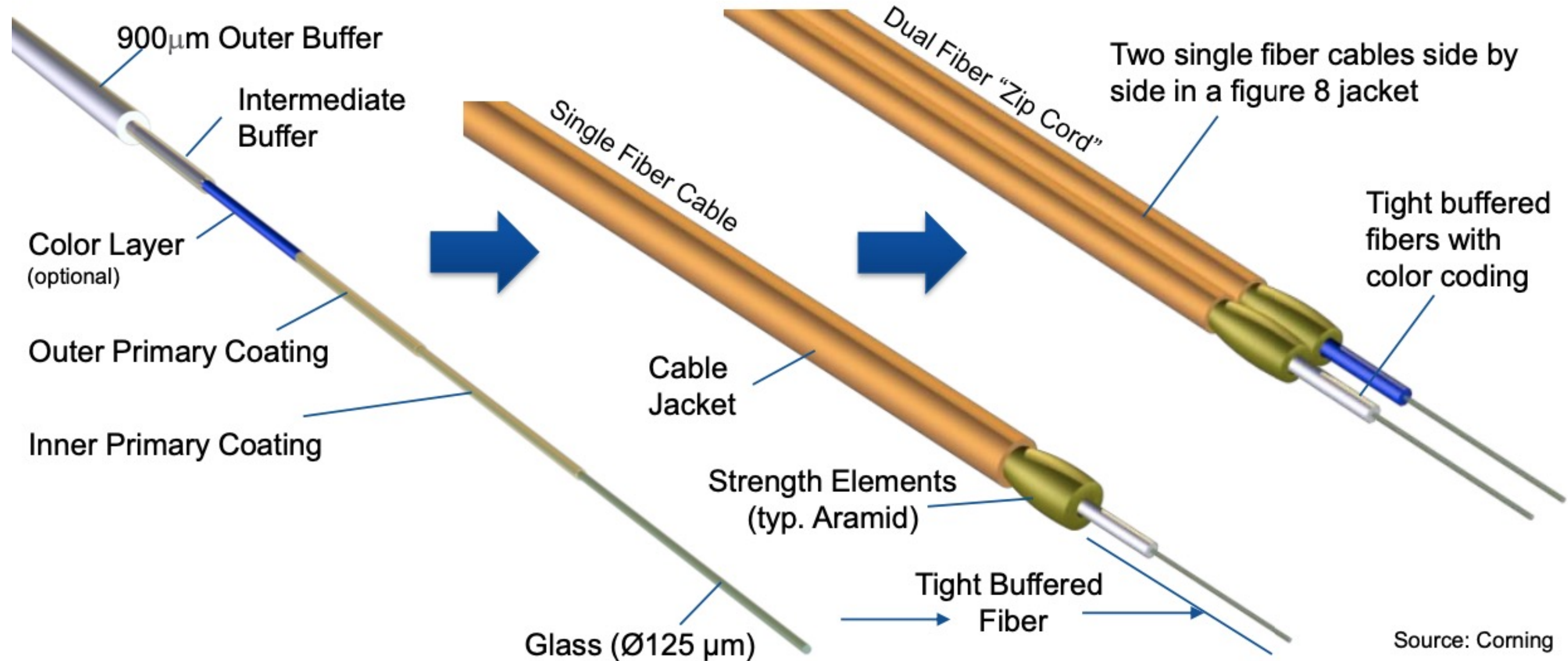


Automotive-grade GOF and connectors



GOF CABLES FOR AUTOMOTIVE

900 μm Tight Buffered Fiber \rightarrow Typical Interconnect Cable



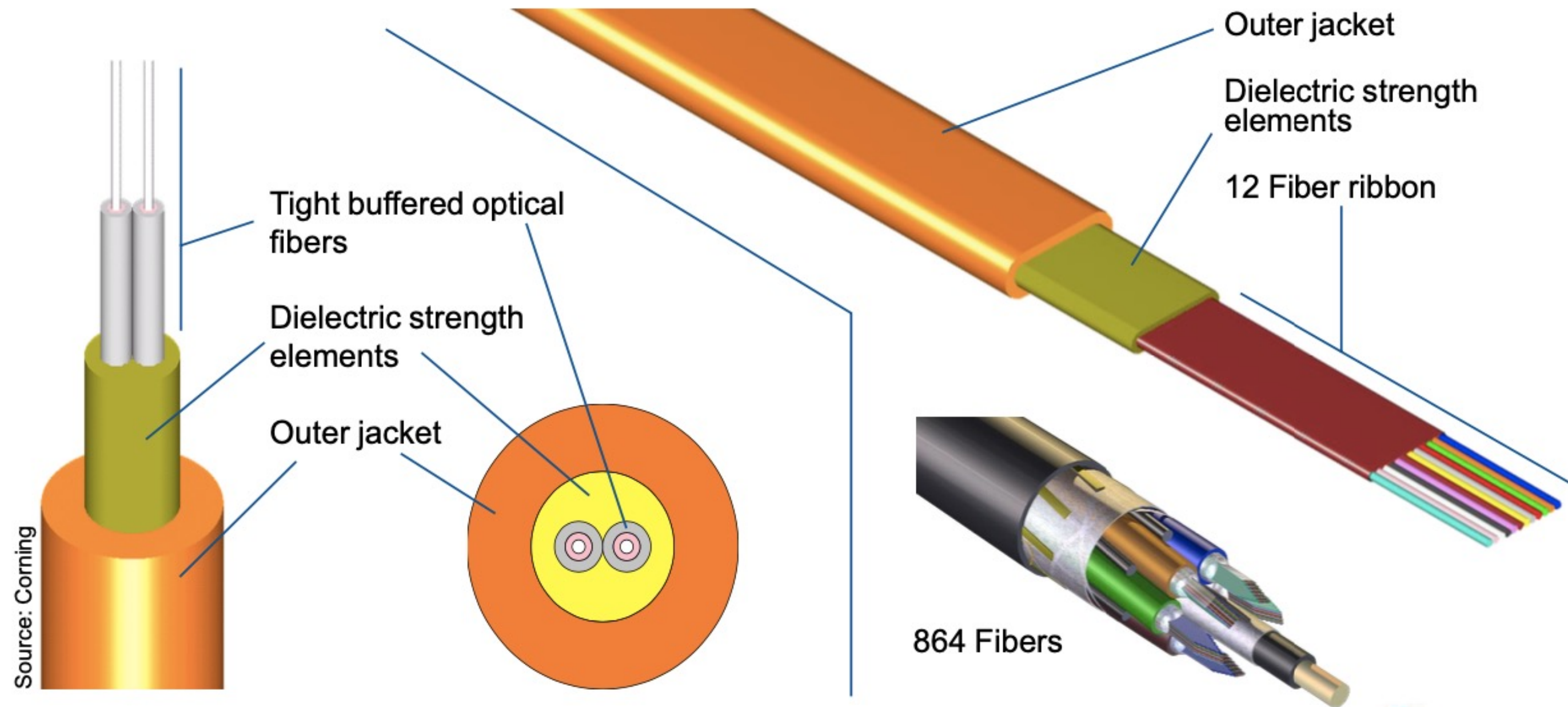
Source: Corning

CONFIDENTIAL



GOF CABLES FOR AUTOMOTIVE

Many Options for Multi-Fiber Cable (selection)



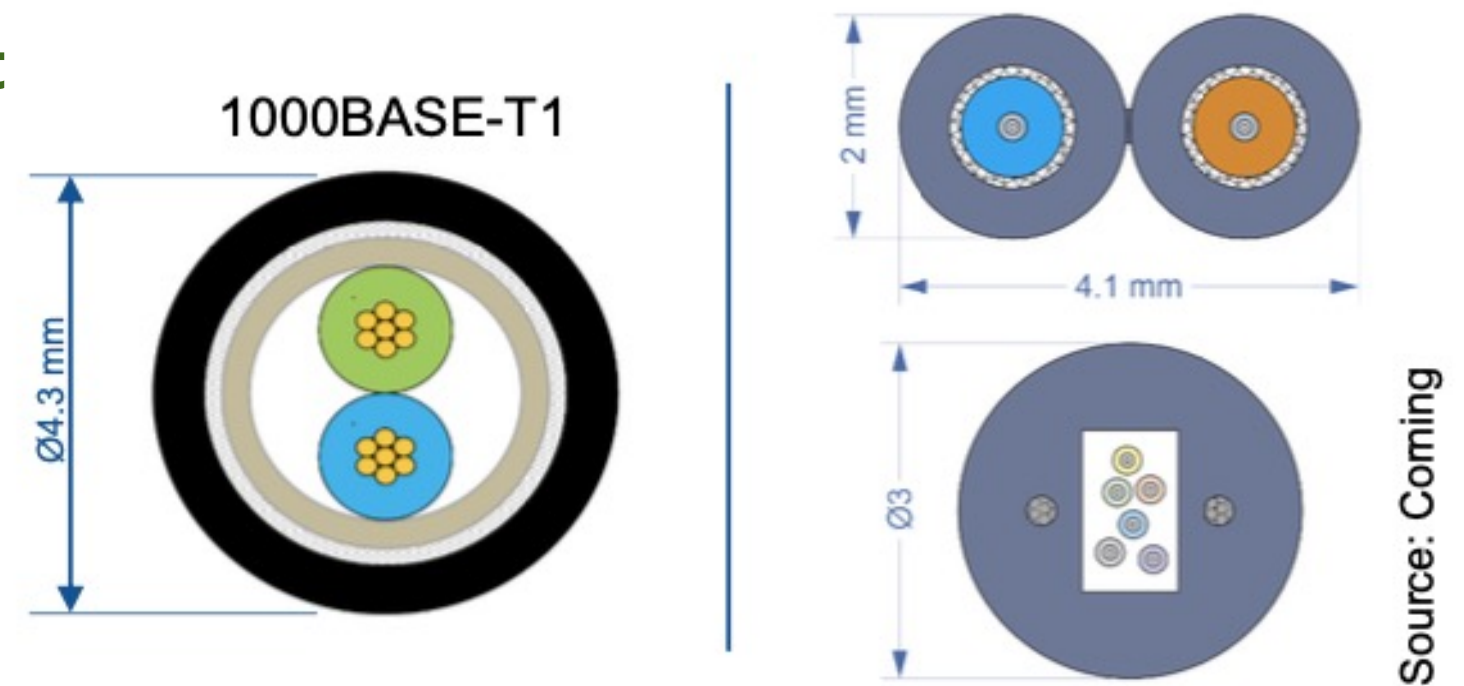
Source: Corning



SCALABLE TECHNOLOGY

Optical cable is smaller/lighter for multi-gigabit

- Electrical communications cable (copper)
 - Insulated to avoid short circuits
 - Conductor pairs to balance signals and minimize cross-talk
 - Shielded to minimize EMC/EMI
 - Increase in data rate → shield (EMI), dielectric layer (x-tak) → more specific
- Glass Optical Fibre Cable
 - Plastic sheets to protect fiber mechanical and environmental factors (i.e. 125°C)
 - Aramid standards for tensile strength (>200N)
 - No need for EMI shielding
 - Increase in data rates → cable size unchanged from 1Gbps up to 100 Gbps.



	1000BASE T1	Optical Cables
"Conductor"	2x AWG26 Cu	2x 125/50 µm Glass
Diameter	4.3 mm	4x2 mm
Weight	23.2 g/m	7.4 g/m
Min. Bend Radius	21 mm	15 mm
Data rate	≤1 Gbps	100+ Gbps

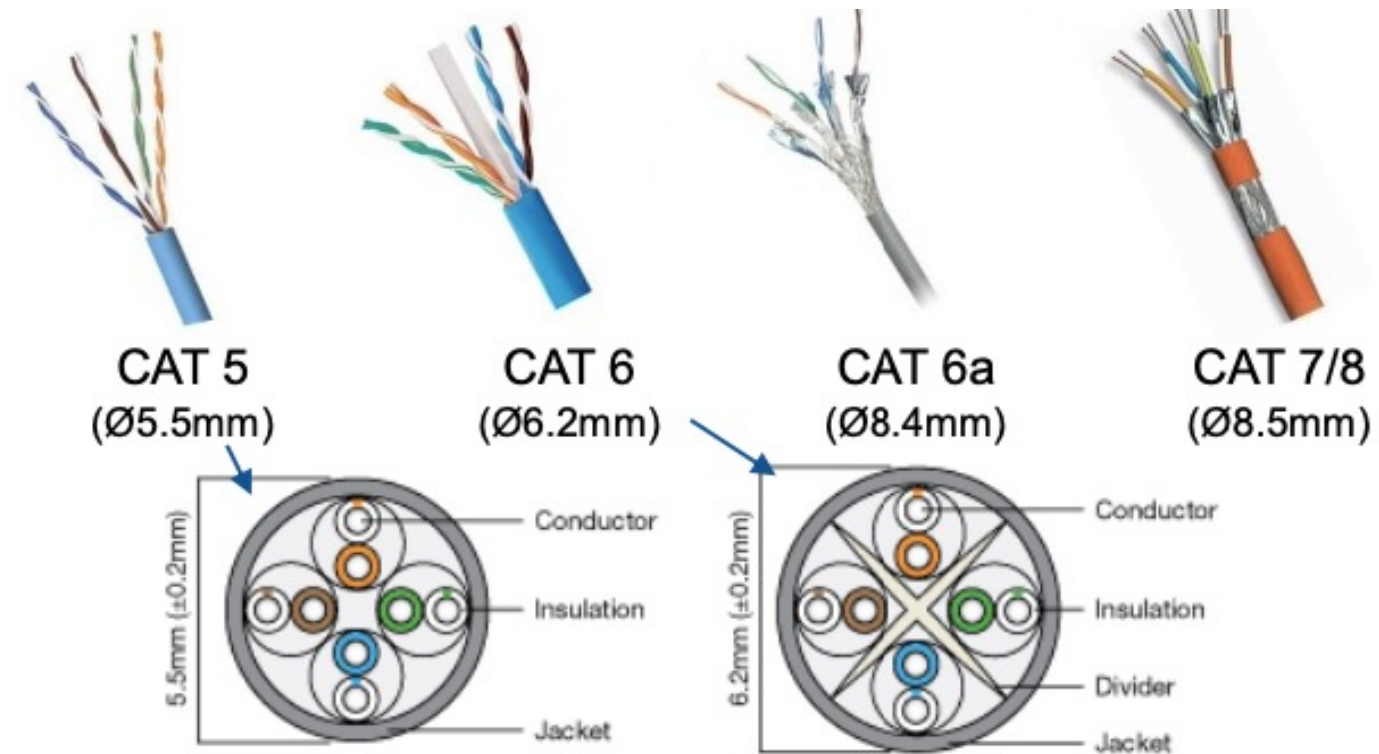


Scalable technology

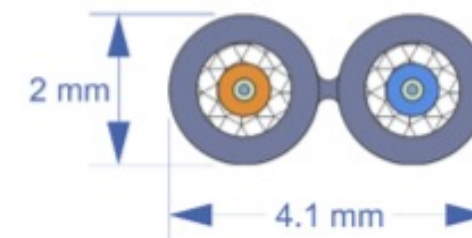
Optical fiber systems can scale to higher data rates w/ same cable design

	Max. Speed	Complexity*	Distance
CAT 3	0.01 Gbps	•	100 m
CAT 5	0.1 Gbps	••	100 m
CAT 5e	1 Gbps	••	100 m
CAT 6	1 Gbps	•••	100 m
CAT 7	10 Gbps	••••	100 m
CAT 8	40 Gbps	•••••	30 m

*... shield, twist, etc.



Fiber	Bandwidth	850 nm*	
MM 50µm	2000MHz.km	40G_{SWDM}	240 m
			<3.0 dB/km



- Same fiber from 0.01–100 Gbps
- Same Cable/Connector design
- No Shielding Needed



OPTICAL FIBER IS INHERENTLY STRONG

2mm

3x Stronger than steel

6x Stronger than titanium

A 2 mm-diameter optical fiber would be strong enough to support the weight of a car.

Optical fiber is 3x stronger than high-tensile steel and 6x stronger than titanium.

The infographic is set against a dark blue background. On the left, a blue car is shown being suspended by a thin white line labeled '2mm'. To the right, there are two illustrations: a grey I-beam steel beam and a grey chain link. Text labels indicate that the fiber is 3x stronger than steel and 6x stronger than titanium. At the bottom, two paragraphs provide further context for these comparisons.

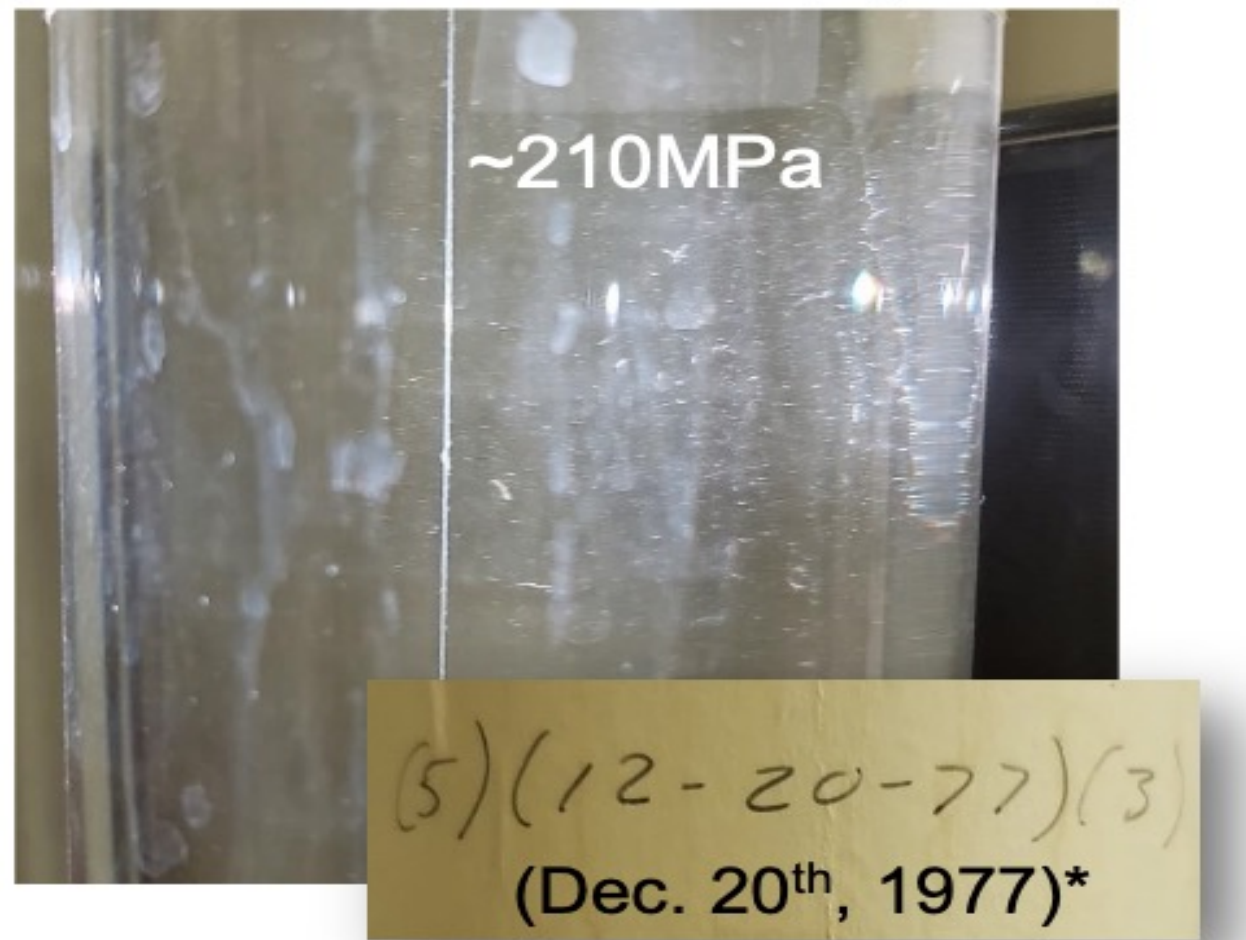
* Source: https://www.corning.com/media/worldwide/global/documents/Optical_Fiber_Infographic.pdf



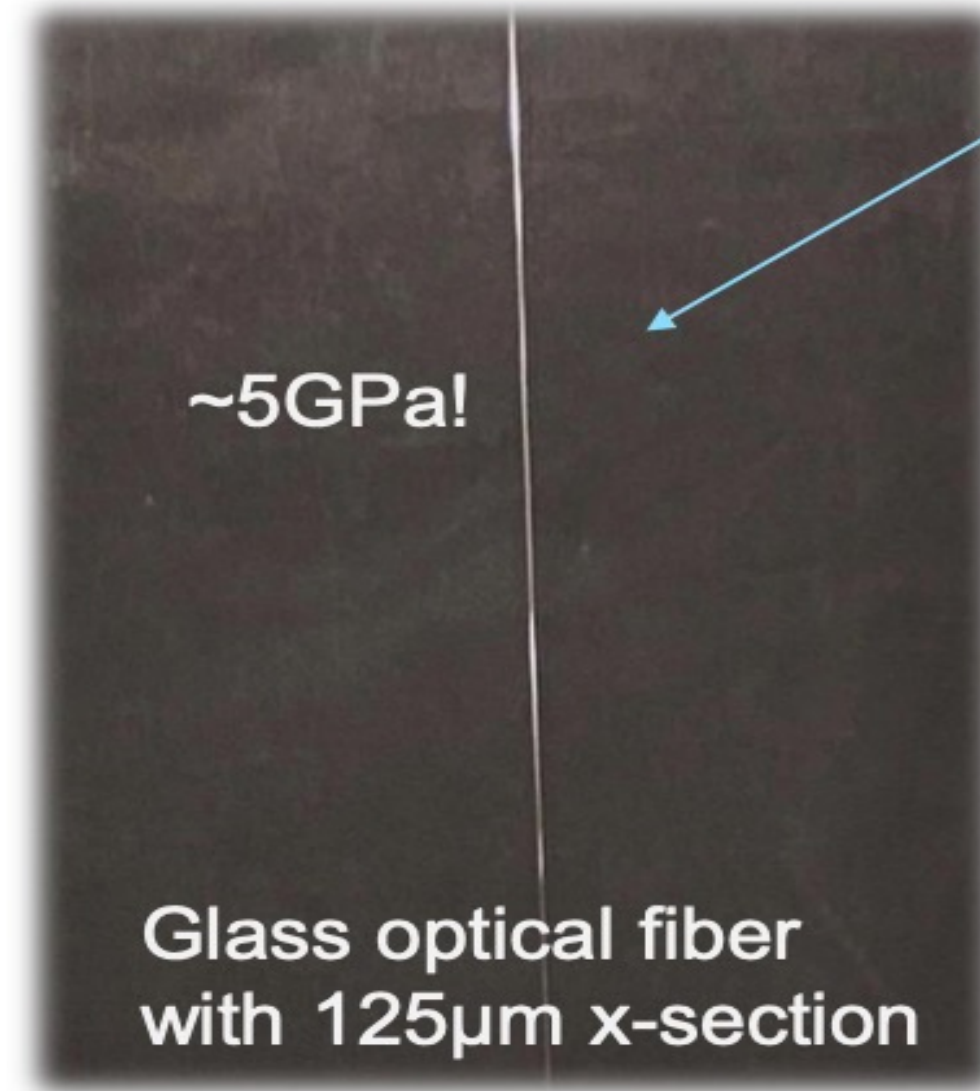
FUSED SILICA WITH VERY HIGH INTRINSIC STRENGTH

Experiments

- Glass optical fibers have been in tension ($F=2.6\text{N}$) for nearly 50 years without breaking (below)



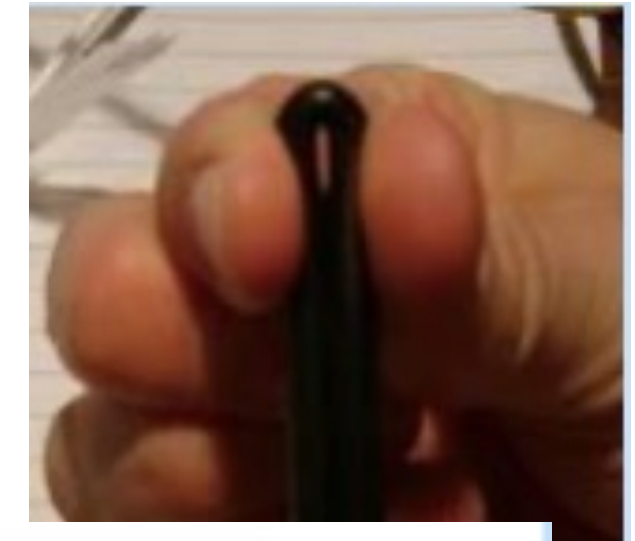
See corning.com for WP8002 & WP1282



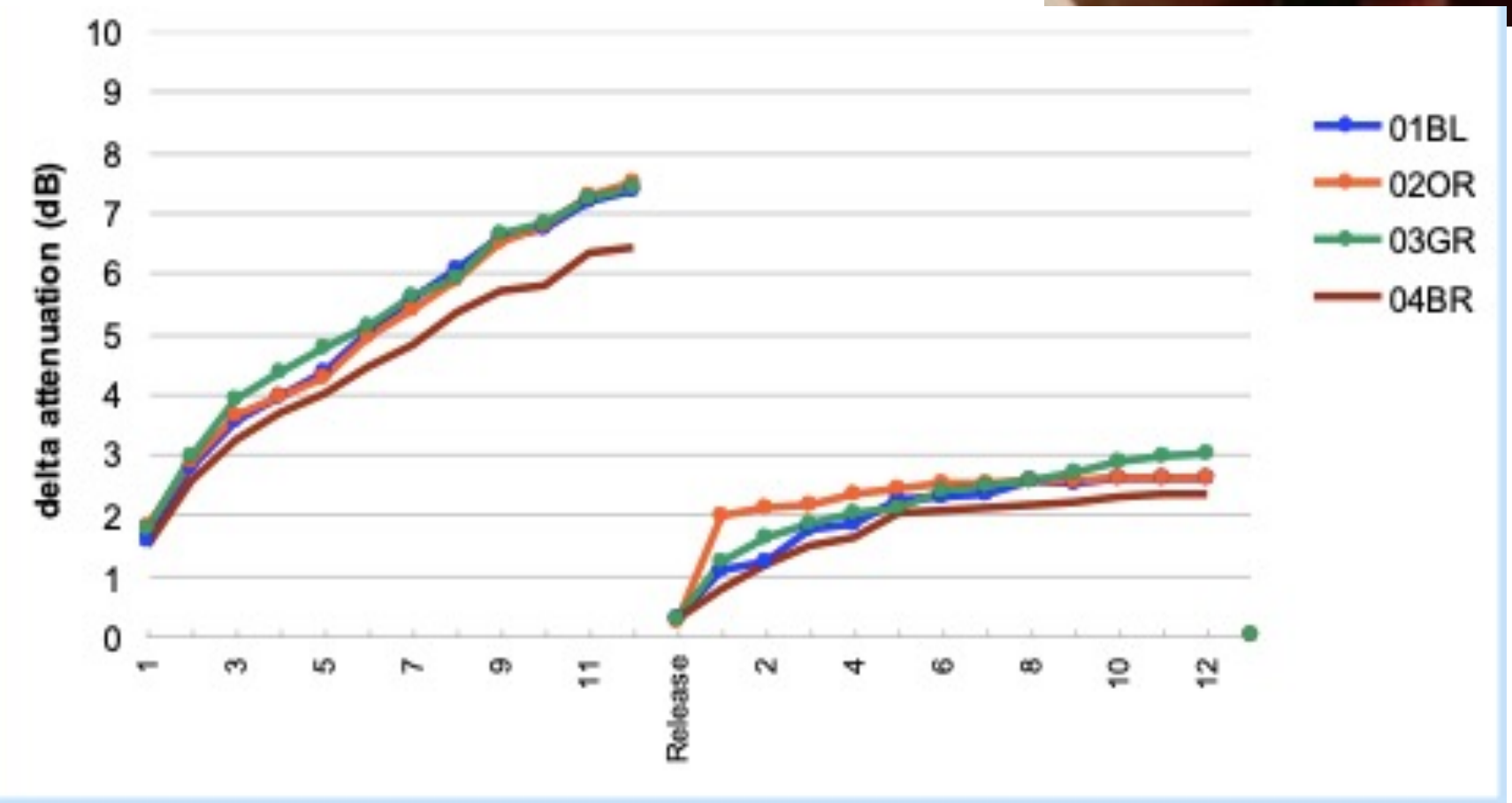


GOF for AUTOMOTIVE

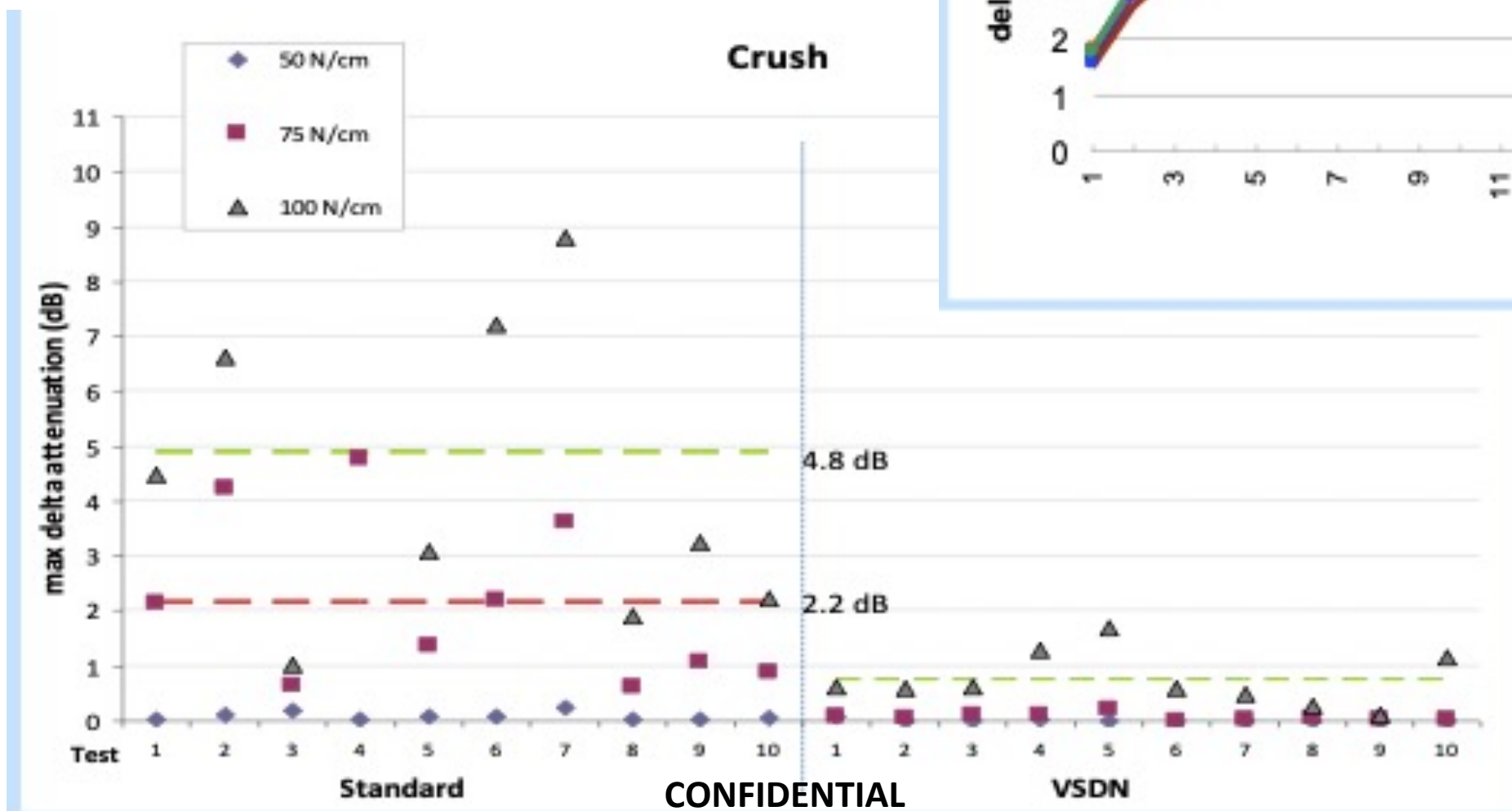
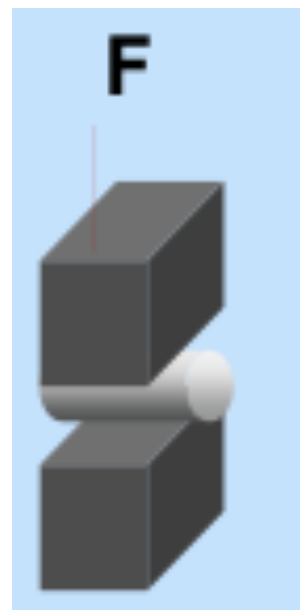
- Environmentally robust fiber cable for challenging applications has been demonstrated



Pinch test



Crush test



Source: Corning



GOF for AUTOMOTIVE: Thermal stability

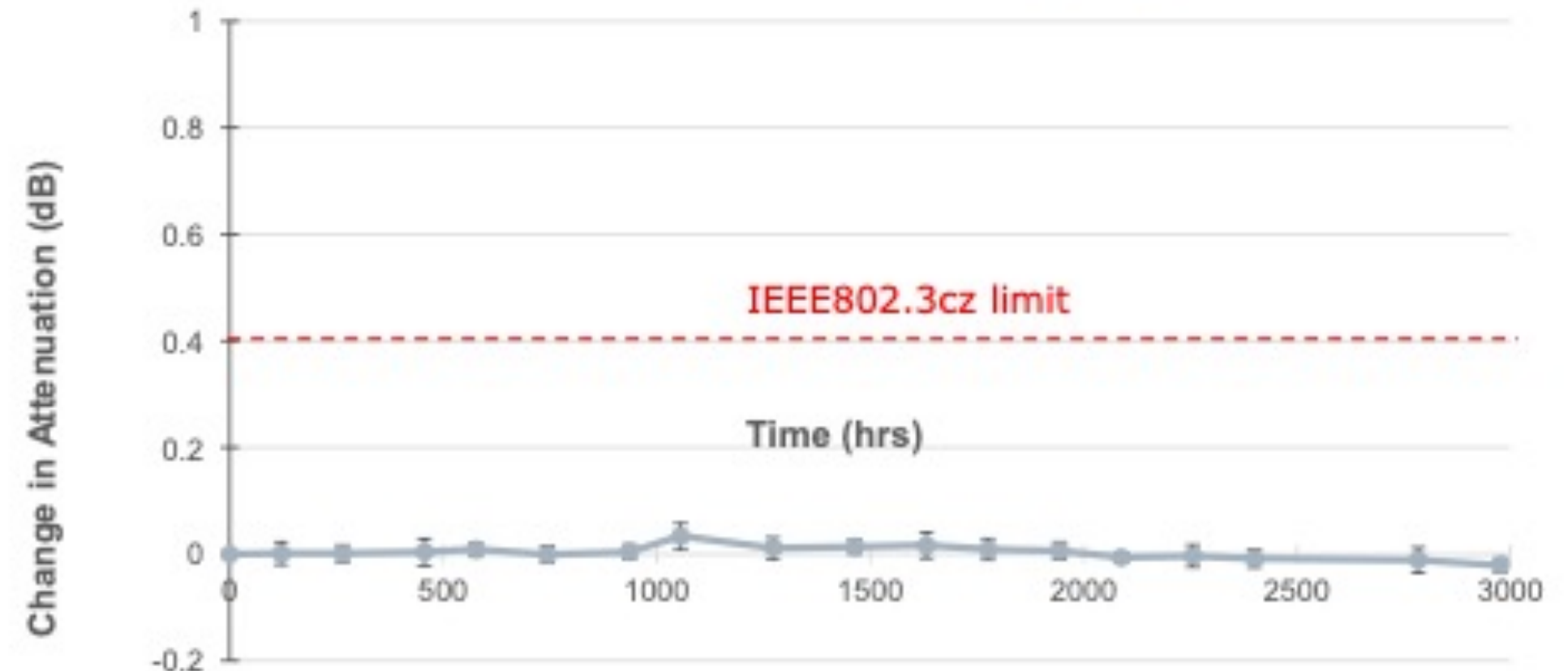
Nominal Target = 105°C, Stretch target = 125°C

***Glass optical fibers and cables inside
thermal aging chamber***



Source: Corning

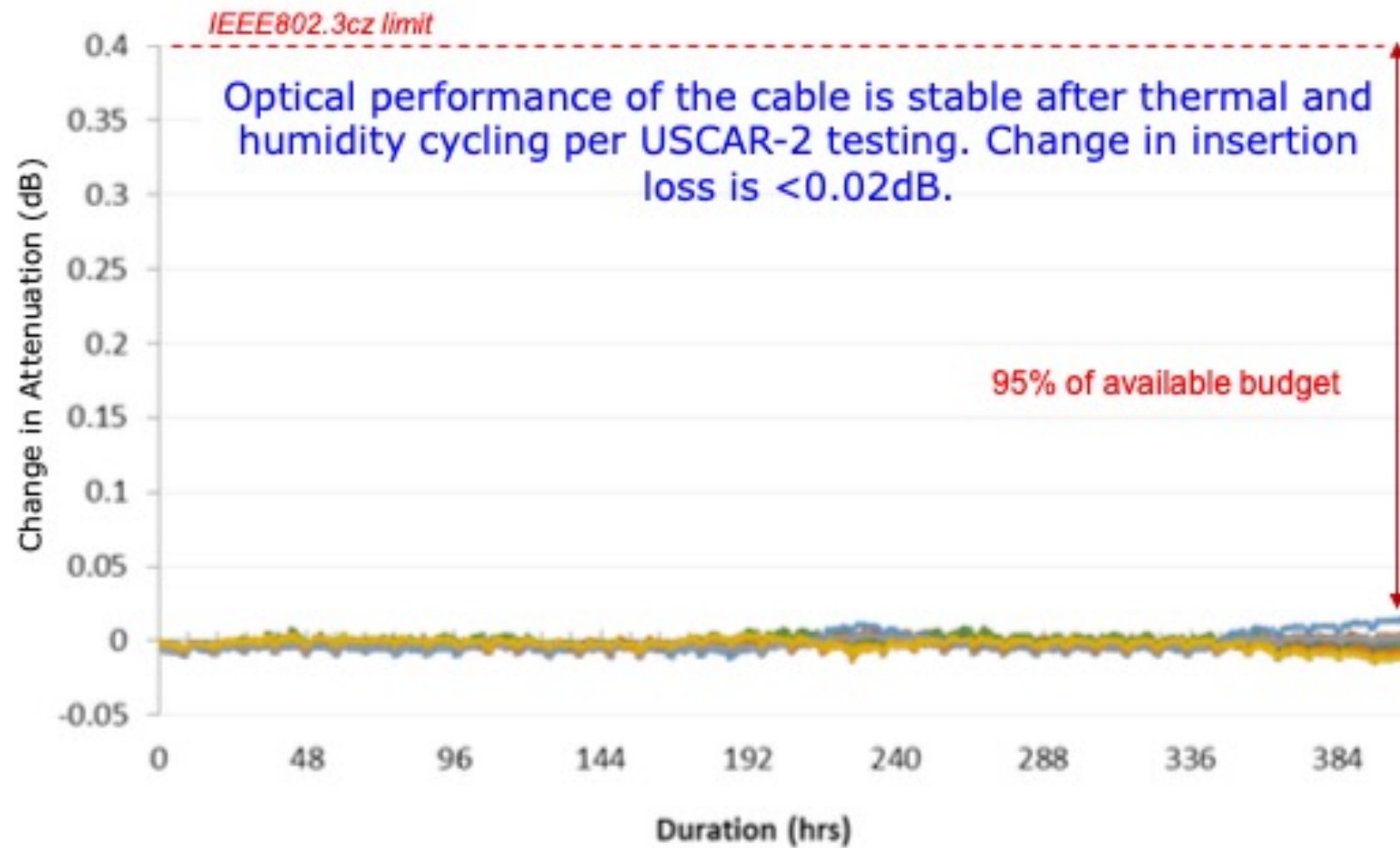
**Less than 0.05dB change in attenuation
after 3000hrs of thermal aging at 150°C**





GOF for AUTOMOTIVE: Environm. cycling

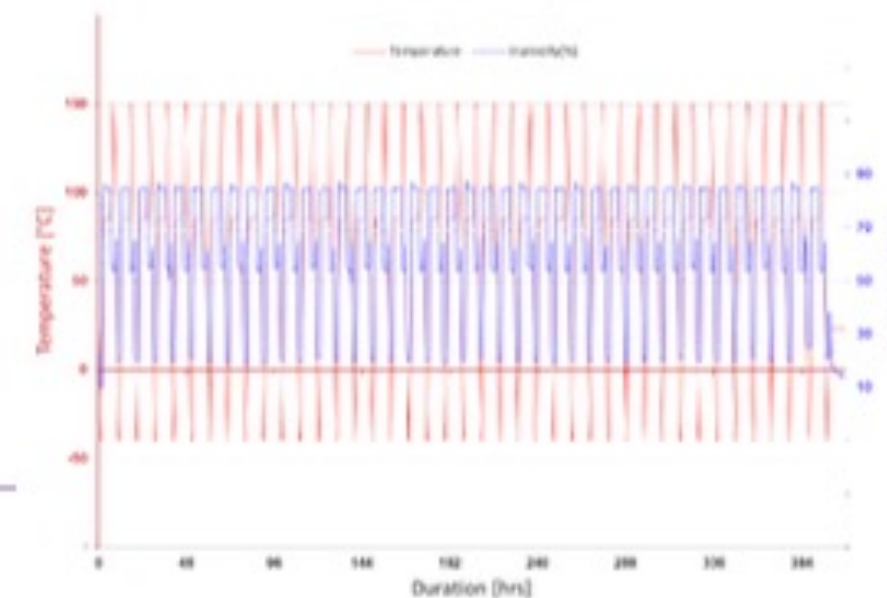
Temp+RH Cycling (-40 to 150C) <0.02 dB



Duration: 400hrs; Temperature: -40°C to 150°C; 10 Samples



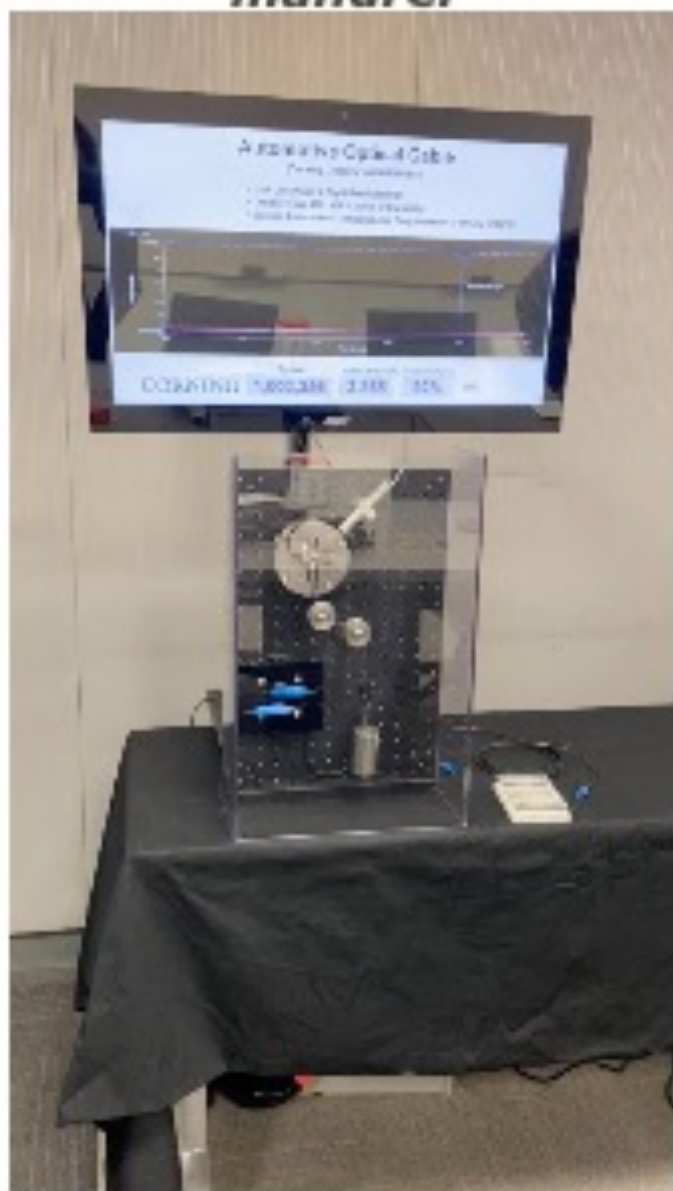
Temperature & Humidity Chart



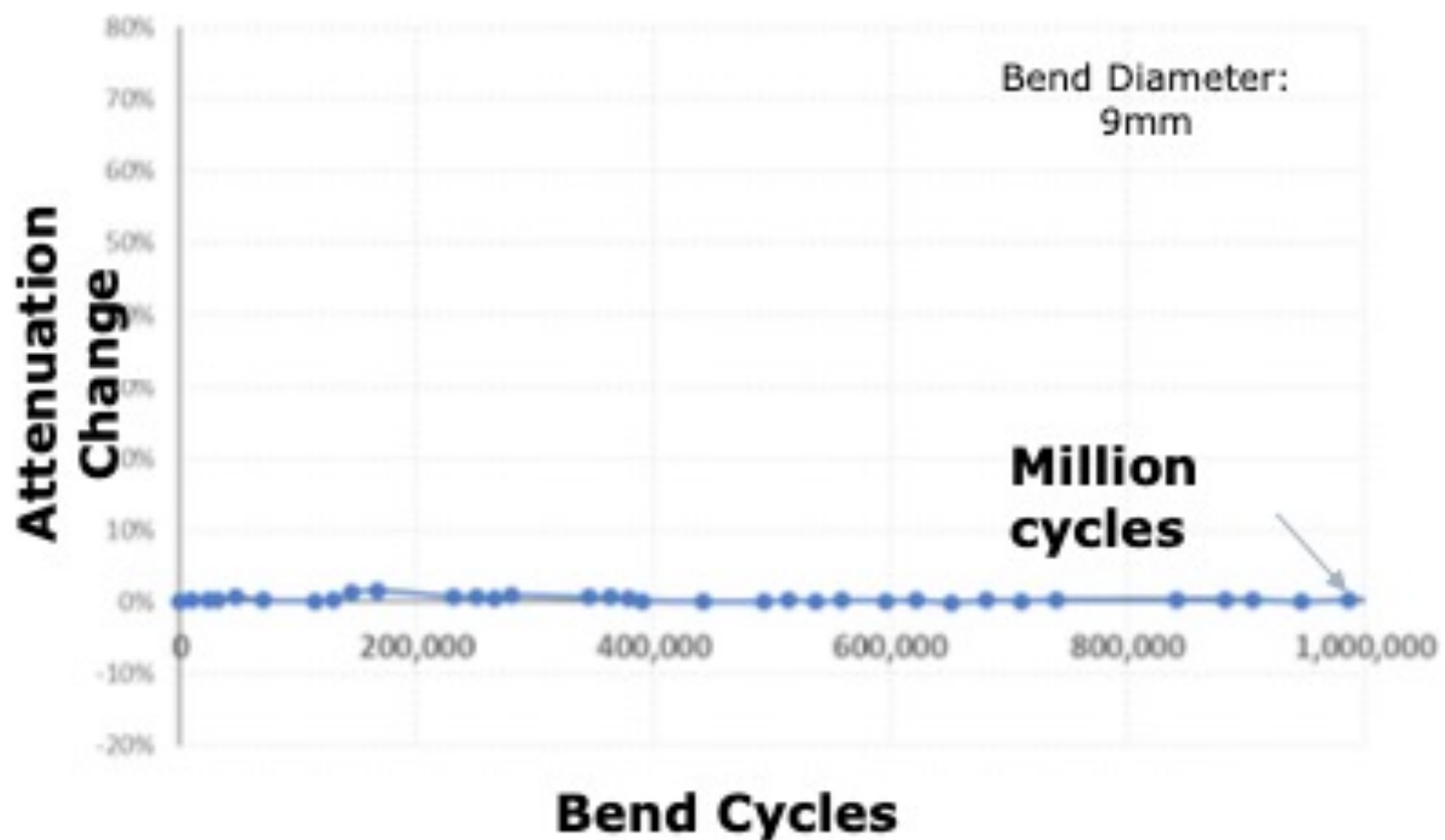


GOF for AUTOMOTIVE: Cyclic bend

Cyclic bending of glass optical cable around 9mm diameter mandrel

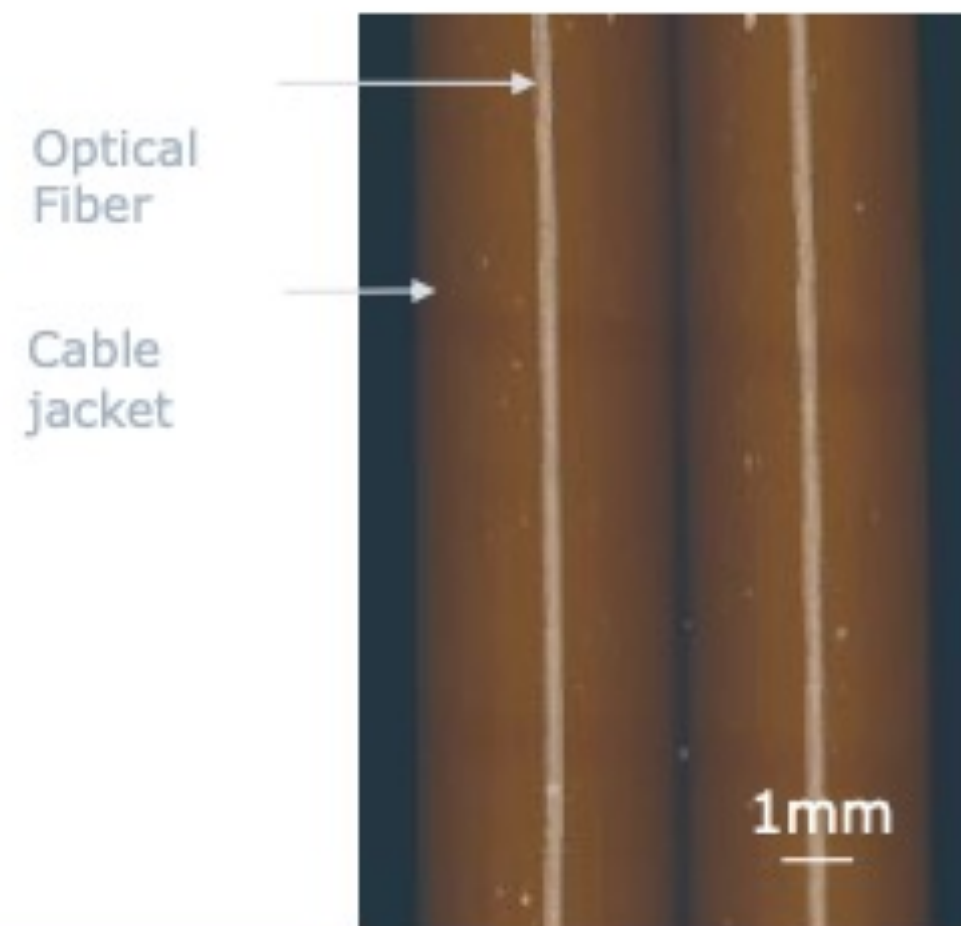


No notable degradation after million bend cycles at 9mm diameter



No fiber damage after bend cycle testing

(X-Ray Microscopy Image)





GOF for AUTOMOTIVE: Chemical loads

Source: Corning

Chemical Exposure

	Chemical	Exposure
1	Gasoline	60 mins @ 23°C
2	Battery alkaline	1 min @ 23°C
3	Mineral hydraulic oil	60 mins @ 85°C
4	Diesel	60 mins @ 23°C
5	Brake fluid	60 mins @ 85°C
6	Window washer fluid	60 mins @ 50°C
7	Transmission fluid	60 mins @ 85°C
8	Battery Acid	1 min @ 25°C
9	Lubrication fluid	60 mins @ 85°C
10	Antifreeze fluid	1 min @ 23°C

Static Mandrel Wrap, 9mm diameter, 2 Months

+



No cracking, swelling or discoloration

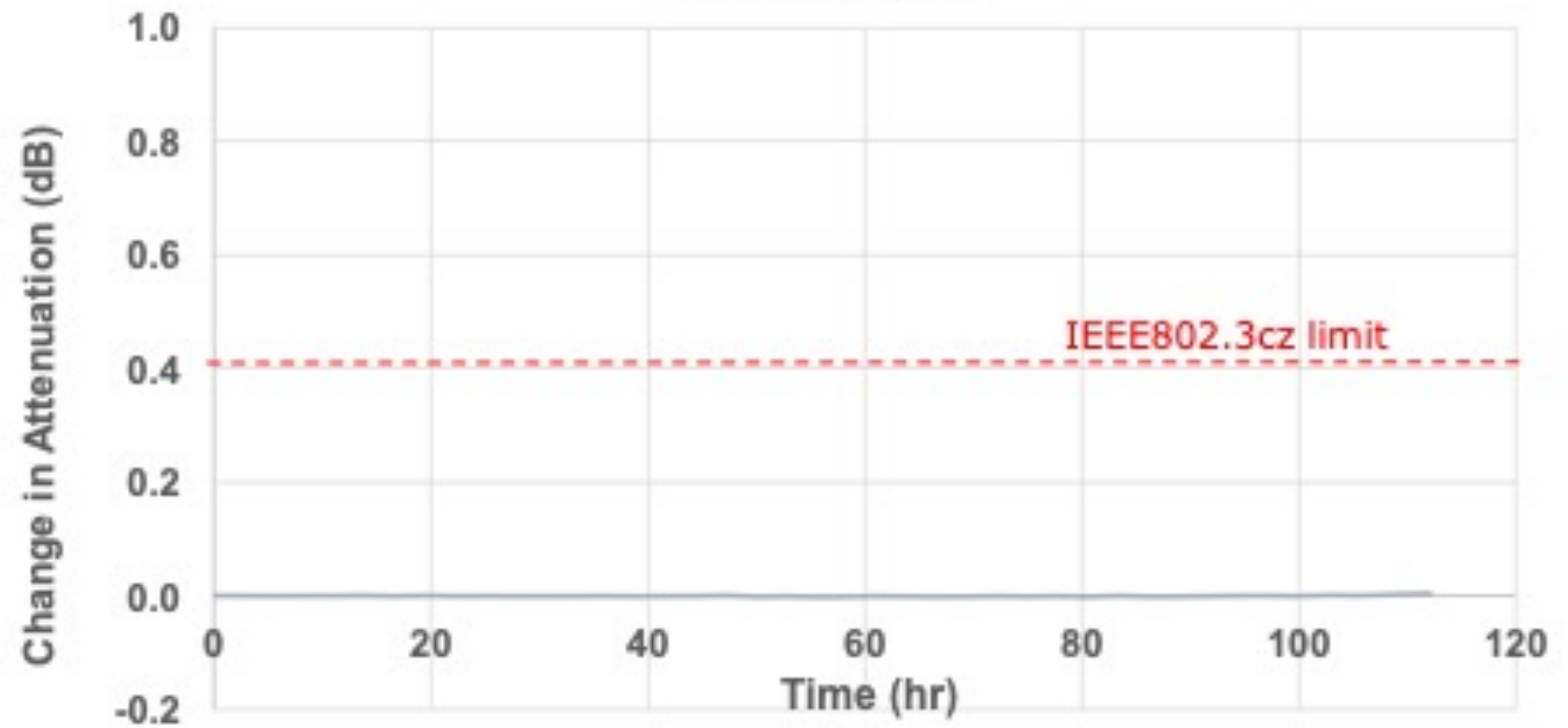


GOF for AUTOMOTIVE: Vibrations

**Connector in vibration (random)
testing**



**No notable change in attenuation after
"random vibration" testing of the
connector**

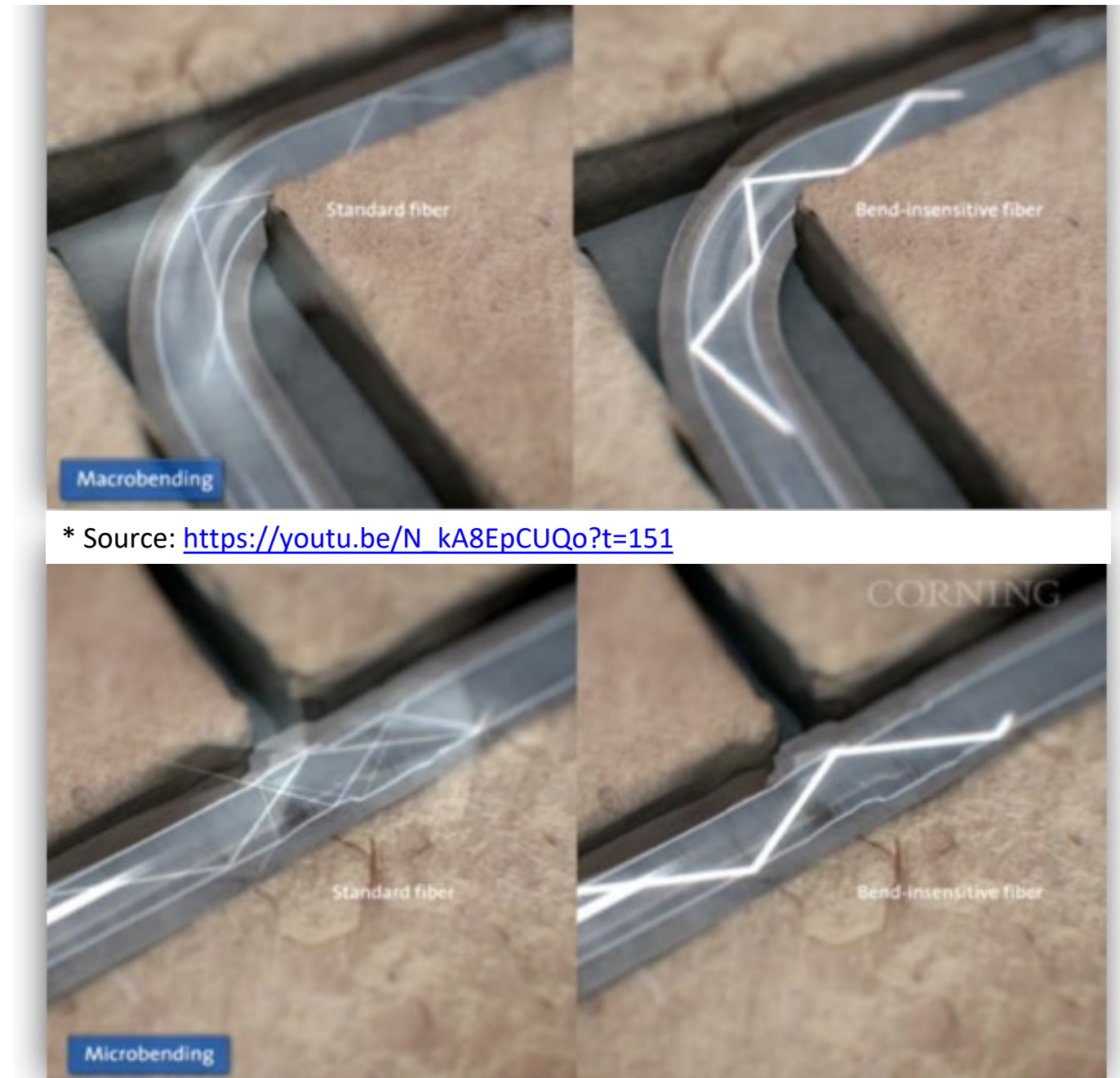
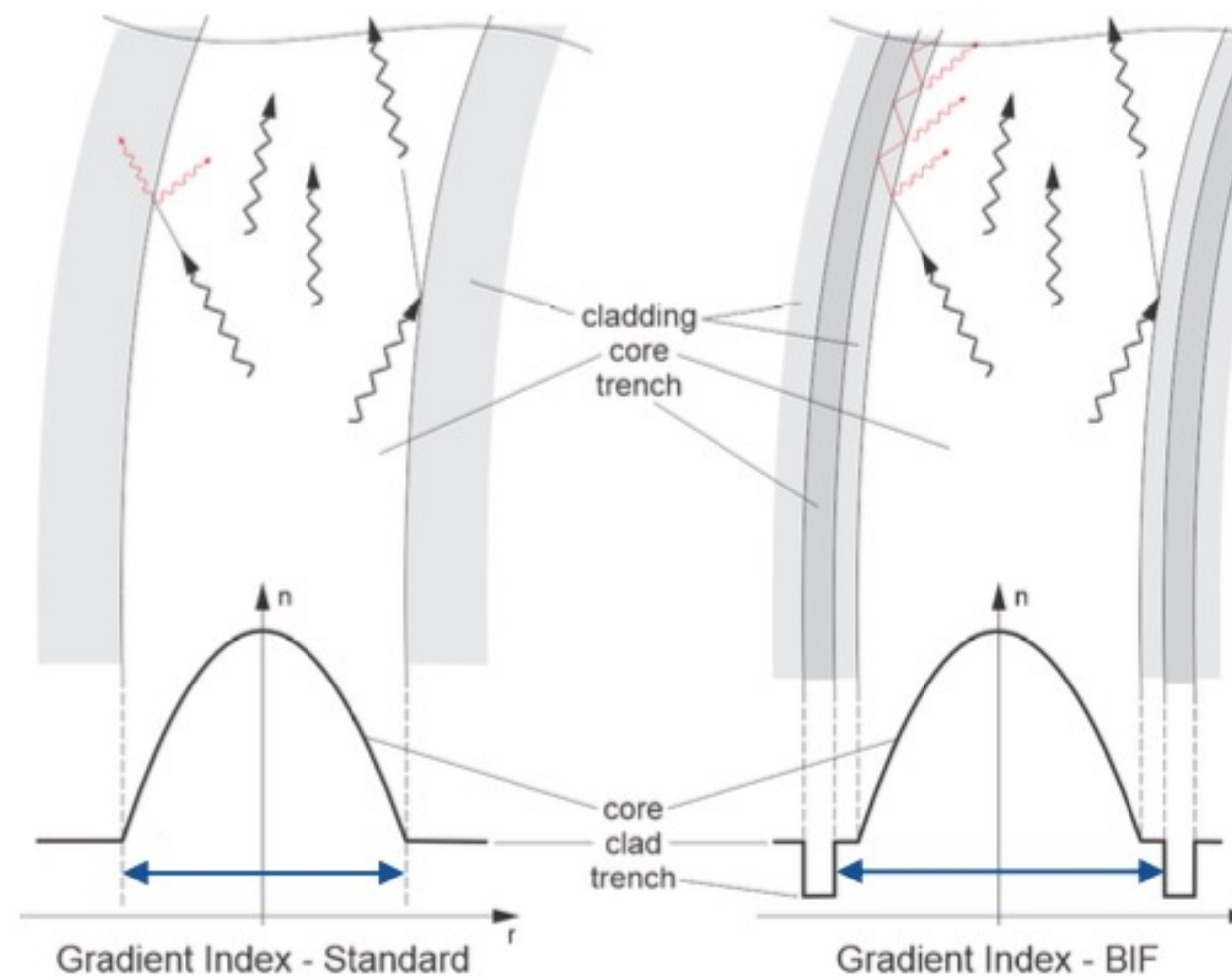




GOF for AUTOMOTIVE

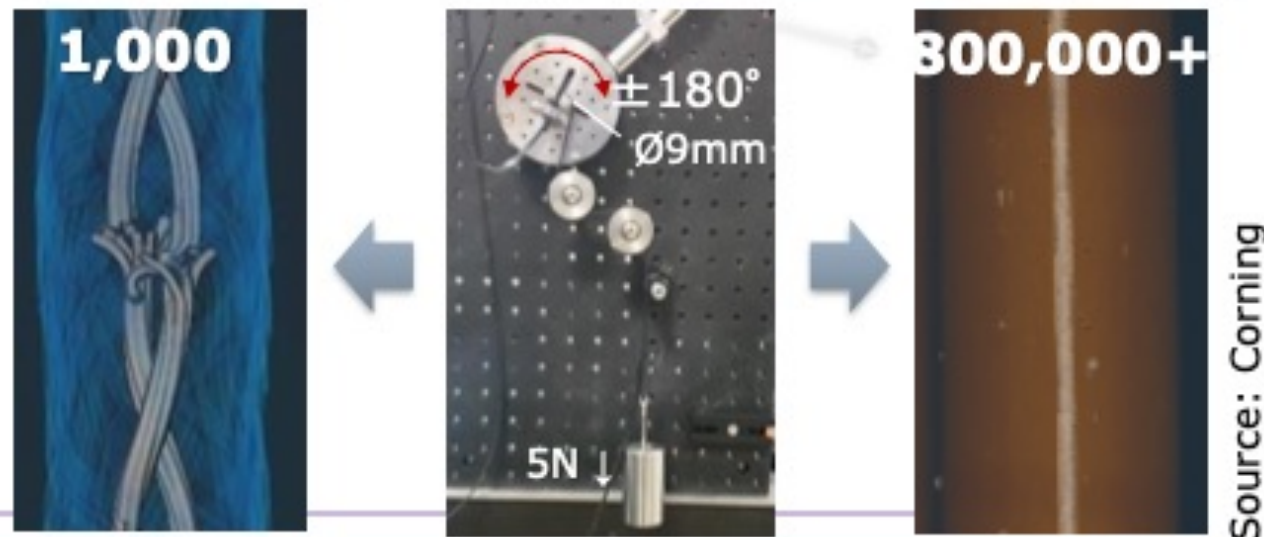
Bend Insensitive Fibers (BIF) for more link margin

BIF adds a layer in the cladding with a lower index of refraction (n) to provide an additional reflection. This guides the light – that would be lost in standard fiber.





REPETITIVE BENDING TOLERANCE



Optical cable can be rugged and flexible

Copper is a ductile material (metal)

- Low yield stress, 69-365 Mpa
- Fatigue (work hardening) and permanent deformation are dislocation-driven once yield stress is exceeded
- High bend radius (e.g. 21mm (STP))
- Tight bends increase Loss/x-talk

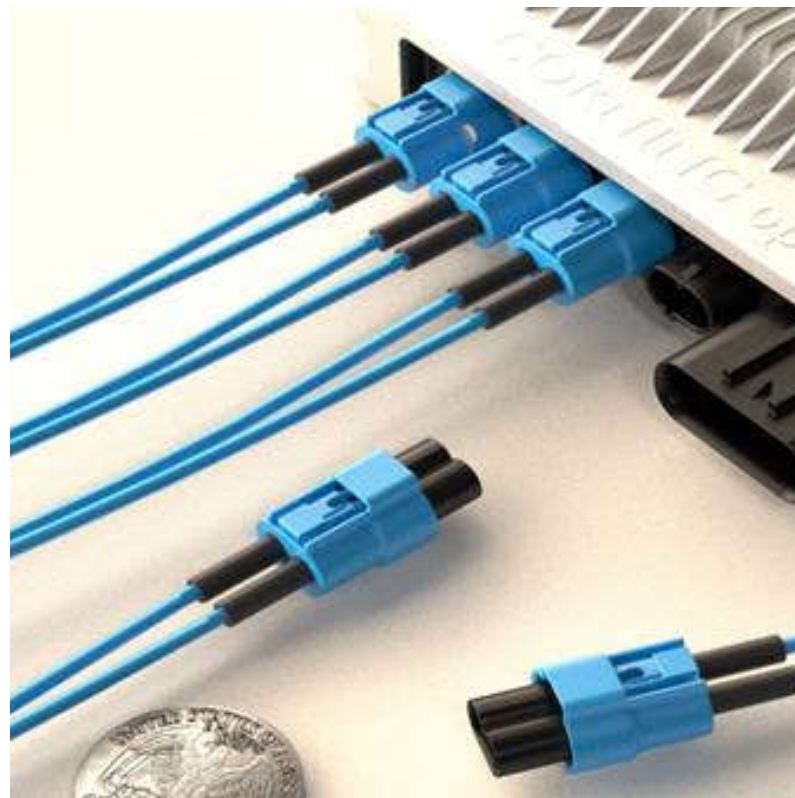
Glass optical fibre is a brittle material

- High intrinsic strength, ~ 5 Gpa
- Is defect driven, not prone to fatigue
- Capable of smaller bend radius (7.5 mm)



GOF CONNECTORS FOR AUTOMOTIVE

building on long history



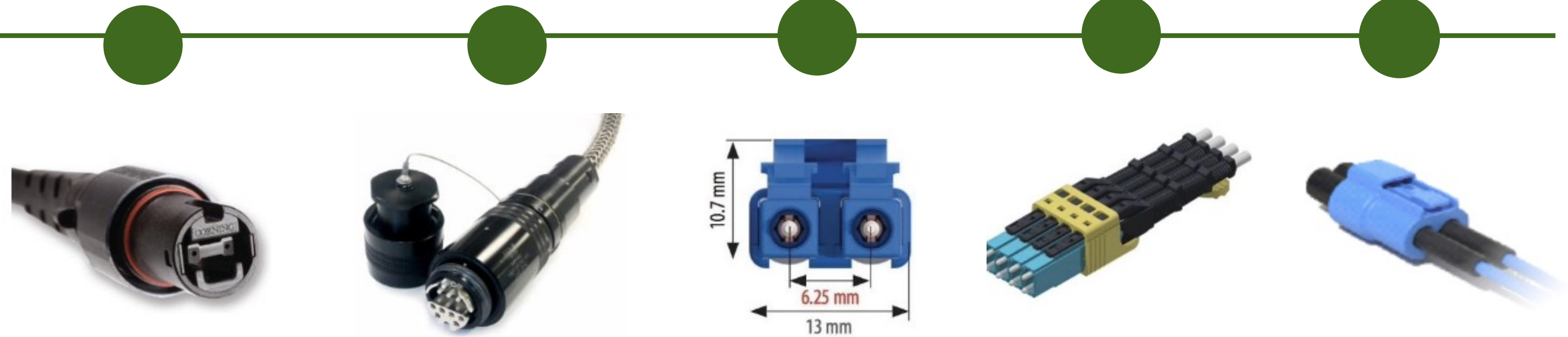
Fiber to the Home

Military

Data Center

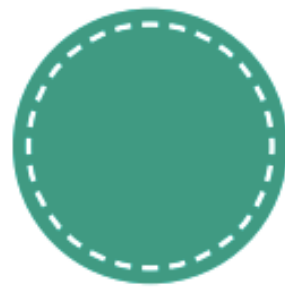
Hyperscale

Automotive





CONNECTOR ROBUSTNESS TO CONTAMINATION



$\varnothing = 3.000 \mu\text{m}$
 $A = 7'068'583 \mu\text{m}^2$
 Factor A = 3.600

Expanded beam

The following diagram is a scale representation of physical contact and expanded beam diameters showing typical contaminant sizes:

Clean Surface	Contaminated	Result
		Dust Particle of $\varnothing = 100 \mu\text{m}$ can cover the full transmission core of the fiber and cleaning is mandatory.
		Dust Particle of $\varnothing = 100 \mu\text{m}$ covers 3.33 % of the lens surface and 90 % of the transmission power is still given.

● Dust Particle $\varnothing = 100 \mu\text{m}$



CONNECTOR ROBUSTNESS TO CONTAMINATION (Other markets use MM GOF in harsh environments)

Lighting & Network



PA Market



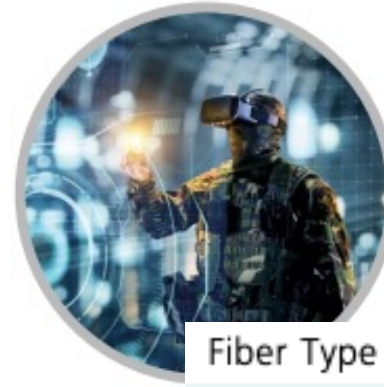
Video



Broadcast



Defense & Government



Railway



Oil & Gas Station



Fiber Type	Multimode
Insertion Loss	Typical 0.7 dB / Connector Maximum 1.0 dB / Connector
Return Loss	N/A
Wavelengths	850 nm / 1300 nm
Lifetime	> 10'000 mating cycles
Tensile Strength	1'800 N
Compressive load	50'000 N
IP Rating	IP68 (mated and unmated)
Free fall Resistance	500 falls onto concrete from 1.2 M height
Bump Resistance	4000 bumps @ 40 g acceleration
Vibrational Sinusoidal	10 - 500 Hz, 0.75 amplitude @ 10 g acceleration
Compatibility	MIL-DTL-83526
Flammability	UL94 V-0
Temperature Range	-40° C to +70° C

CONFIDENTIAL



CONNECTOR ROBUSTNESS TO CONTAMINATION (Other markets use MM GOF in harsh environments)

